

DANAE - a new experiment for direct dark matter detection with DEPFET silicon detector

Hexi Shi
HEPHY ÖAW

DANAE (DANAË)

Direct dArk matter search using DEPFET with repetitive- Non-destructive-readout Application Experiment

OeAW funding for detector technology



"Danae" by G. Klimt

Collaboration



Austria

A. Bähr ^A, J. Ninkovic ^A, J. Treis ^A,
H. Kluck ^{B,C}, J. Schieck ^{B,C}, H. Shi ^B,



Germany

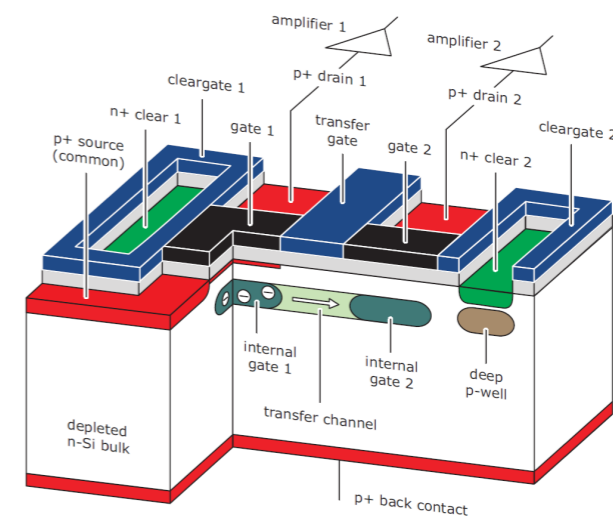
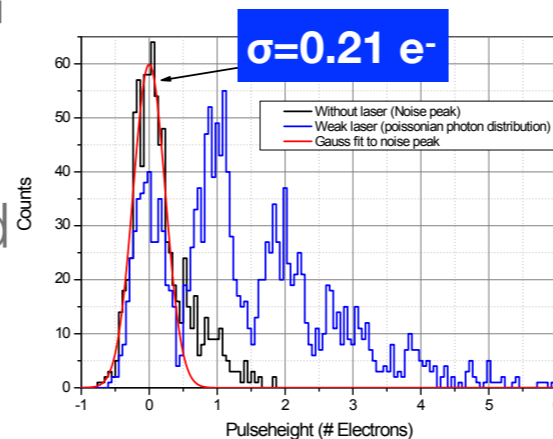
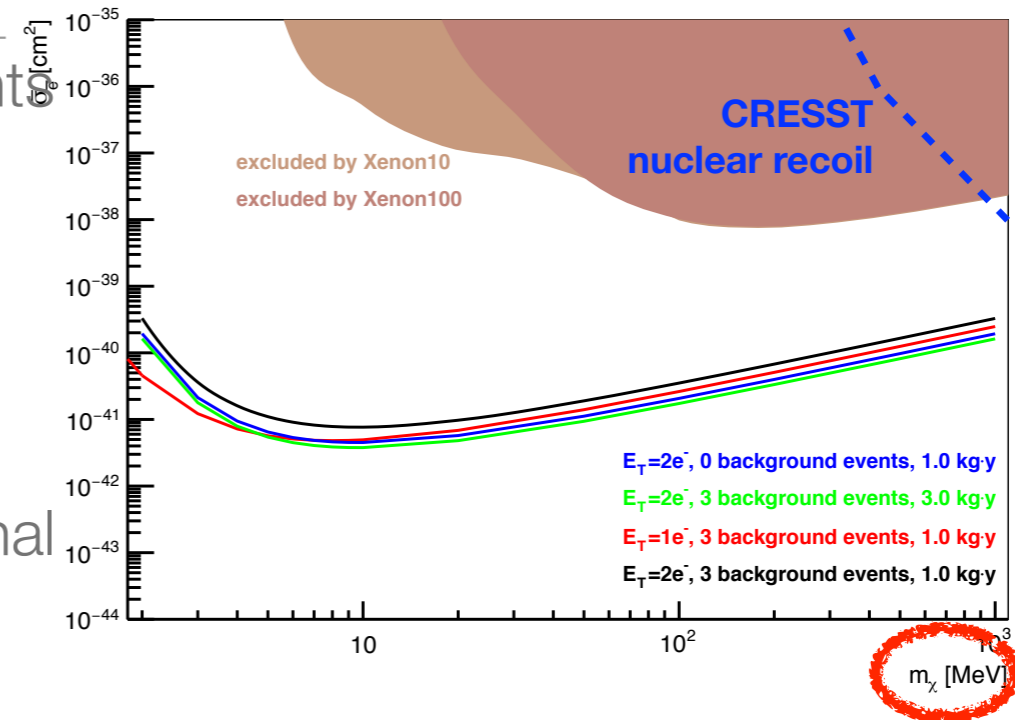
Max-Planck-Gesellschaft Halbleiterlabor, Germany ^A,

Institut für Hochenergiephysik der Österreichischen Akademie der Wissenschaften, Vienna, Austria ^B,
Atominstitut, Technische Universität Wien, Vienna, Austria ^C

The project overview

Direct Dark Matter Detection with DEPFET

- minimal reach for nuclear recoil experiments about few 100 MeV
- dark matter electron scattering offers **reach towards MeV dark matter**
- measurement of **low noise** ionisation signal in **low background** environment
- RNDR* DEPFET sensors developed by semiconductor laboratory of MPG
- setup for **proof-of-principle measurement** currently prepared
- expect first results early 2019**

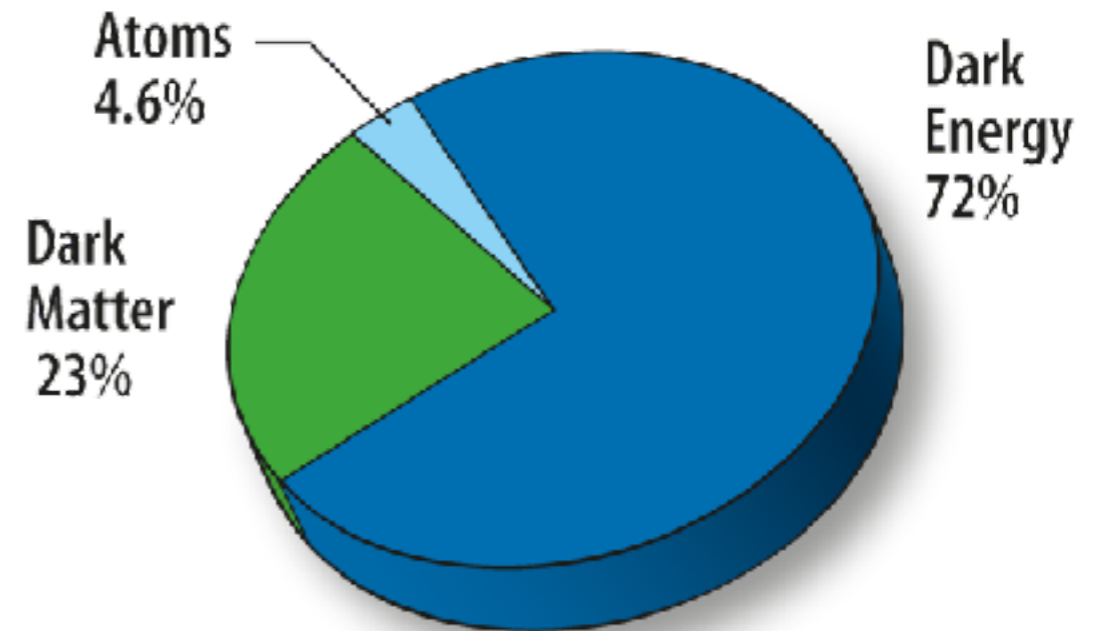


EPJ C, 77(12), 279 (2017)

*Repetitive Non-Destructive Readout

Dark matter landscape - partly

Over 80% of the mass in the universe is invisible dark matter



TODAY

Credit: NASA / WMAP Science Team

“WIMP” as a dark matter candidate :

- weakly interacting with matter

$$\langle \sigma_{\text{WIMP}} \cdot v \rangle \sim G_F^2 \cdot m_X^2 \sim 1/\Omega_X$$

- fits the Hubble constant and “relic” density of dark matter

predicts dark matter WIMP mass between 2 GeV and 120 TeV



WIMPs

dominated the direct detection experiments until recently

WIMP direct detection method

look for nuclear recoils from
WIMP-nucleus scattering

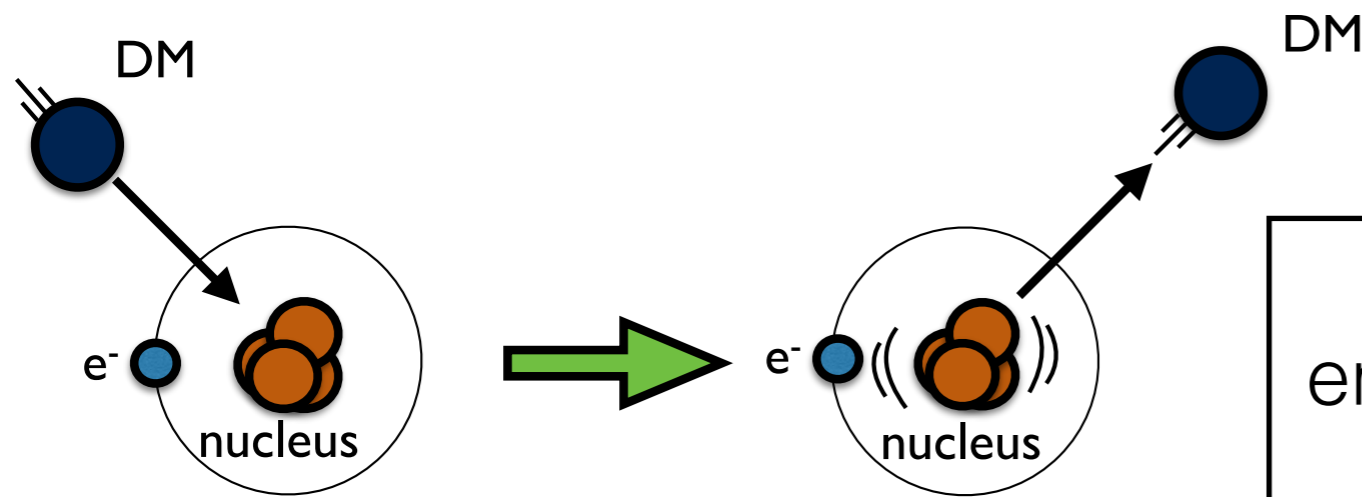


image credit R. Essig

Energy deposit in target
material in forms of :

- light
- phonon
- electric charge

Detection limitation :
energy deposit from nucleus recoil
 $E_{NR} \sim 2\mu_{\chi,N}^2 \cdot v_{\chi}/m_N$

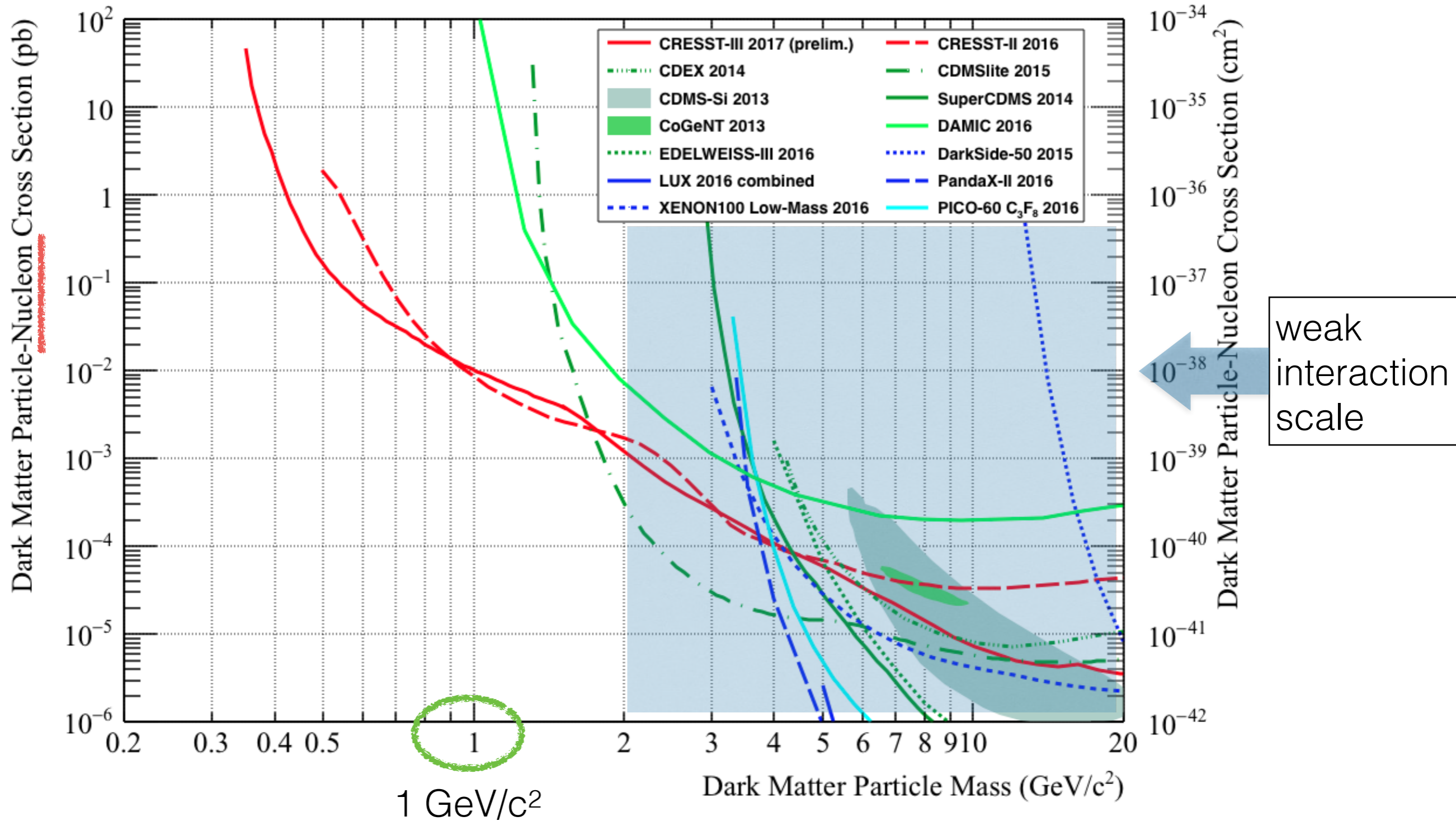
-> for 100 MeV m_{χ} , $E_{NR} \sim 1$ eV *

plus quenching factors and
noise level of the detectors

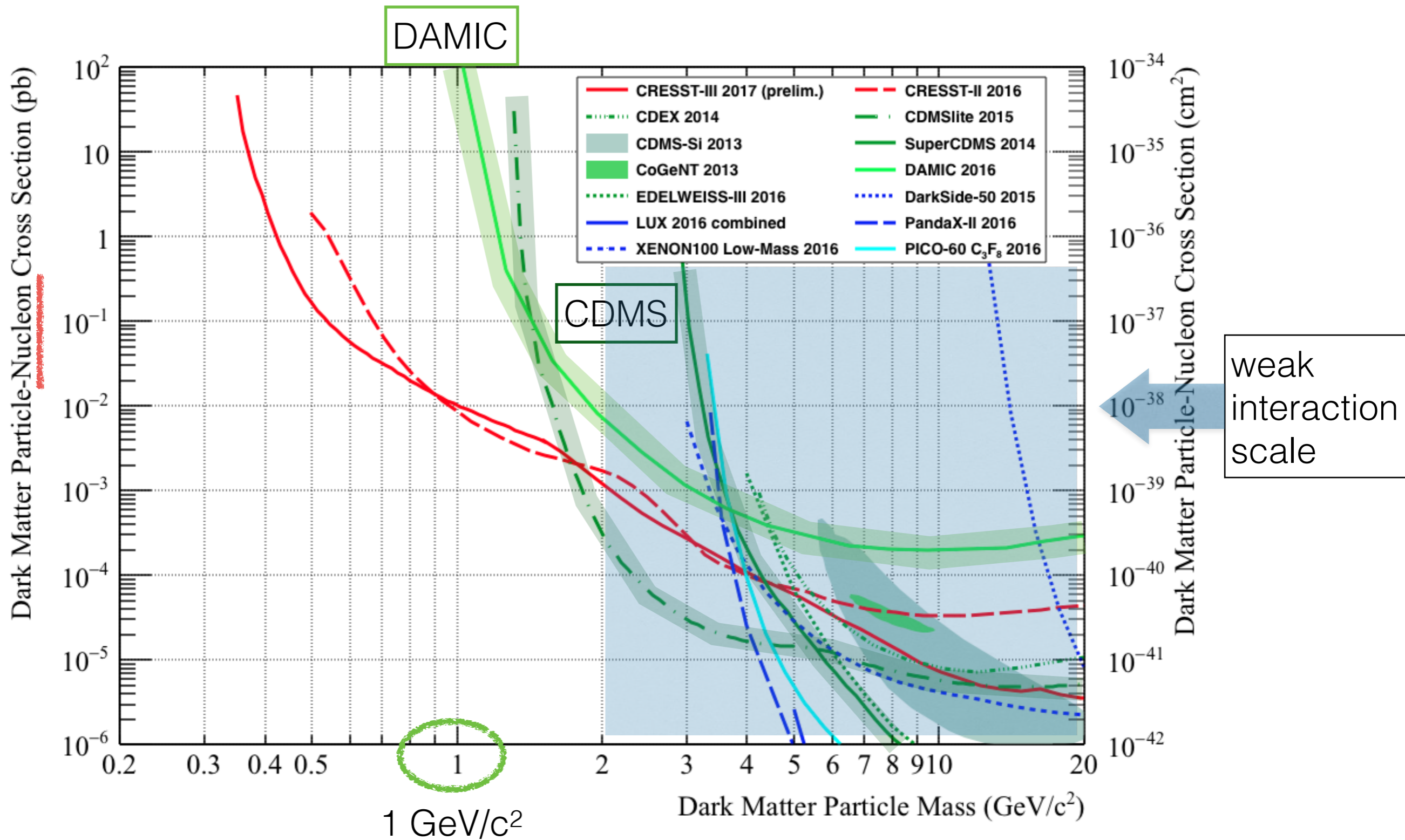
typical DM velocity $v_{\chi} \lesssim 800$ km/s

*for silicon

DM-nucleus scattering direct search status



DM-nucleus scattering direct search status



Dark Sector and Light Dark Matter

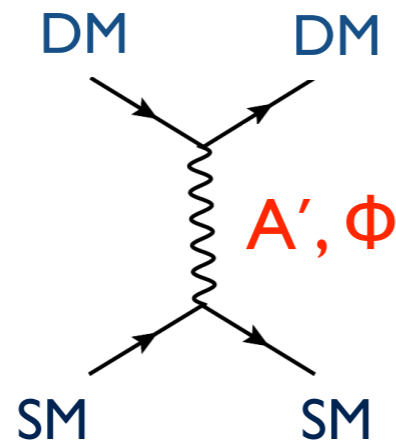


Dark sectors
(DM + new mediators)

WIMPs

several sharp “theory” targets
(freeze-out, asymmetric, freeze-in, SIMP, ELDER)

Dark sector :
interaction between DM and standard model particle mediated by a dark photon
(one example of mediators)



DM scattering

clear predictions from multiple models over wide DM mass region, including keV ~ GeV range
-> comparable observables in experiments

image credit R. Essig

DM-electron scattering

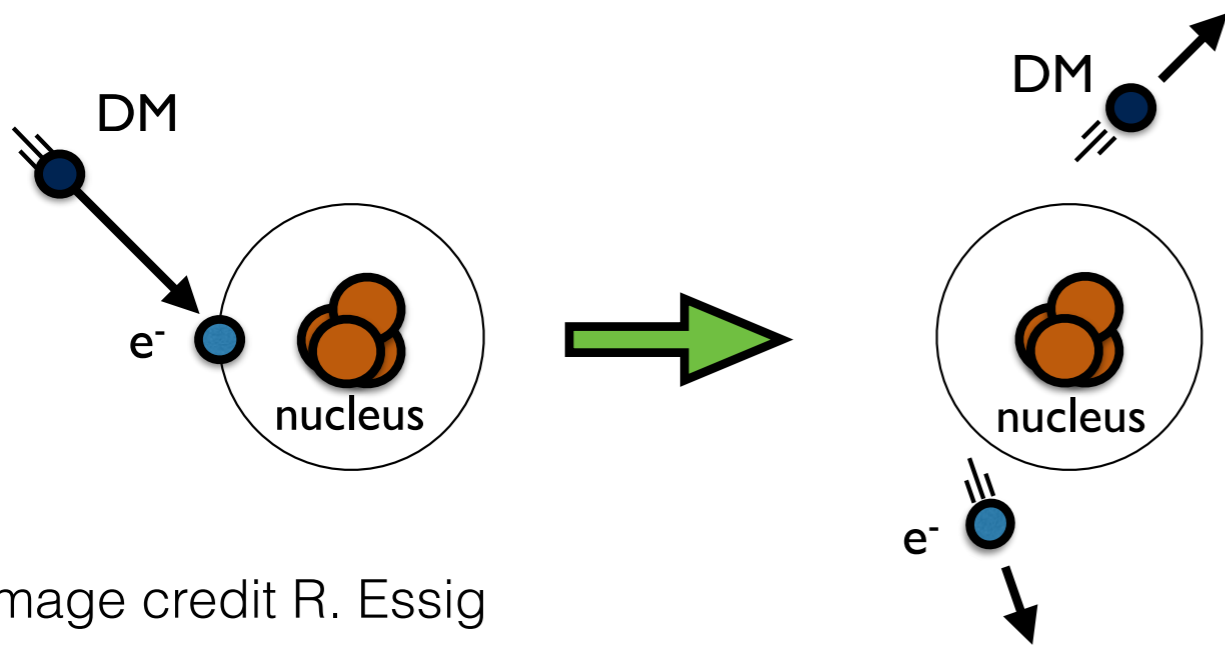


image credit R. Essig

kinematically

to overcome binding energy ΔE

$$\text{need } E_{\text{DM}} \sim \frac{1}{2} m_{\text{DM}} v_{\text{DM}}^2 > \Delta E$$

$$v_{\text{DM}} \lesssim 800 \text{ km/s} \implies m_{\text{DM}} \gtrsim 300 \text{ keV} \left(\frac{\Delta E}{1 \text{ eV}} \right)$$

O(100 keV)

DM-electron scattering

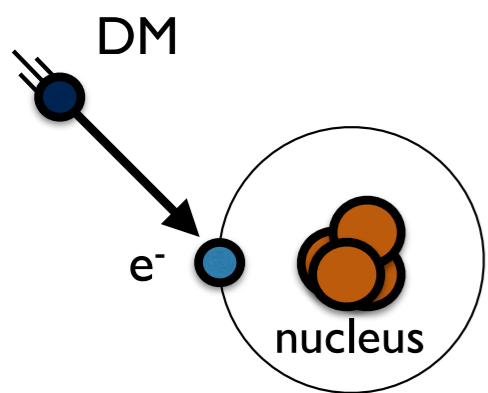
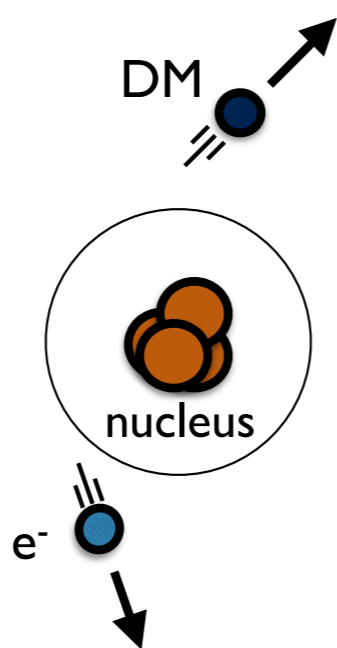


image credit R. Essig



kinematically

to overcome binding energy ΔE

$$\text{need } E_{\text{DM}} \sim \frac{1}{2} m_{\text{DM}} v_{\text{DM}}^2 > \Delta E$$

$$v_{\text{DM}} \lesssim 800 \text{ km/s} \implies m_{\text{DM}} \gtrsim 300 \text{ keV} \left(\frac{\Delta E}{1 \text{ eV}} \right)$$

O(100 keV)

bound e^- does not have definite momentum,
typical momentum transfer is set by e^- not by DM.

$$q_{\text{typ}} \sim \alpha m_e \sim 4 \text{ keV}$$

(for outer shell electron)

$$\text{transferred energy: } \Delta E_e \sim \vec{q} \cdot \vec{v}_{\text{DM}}$$

$$\Delta E_e \sim 4 \text{ eV}$$

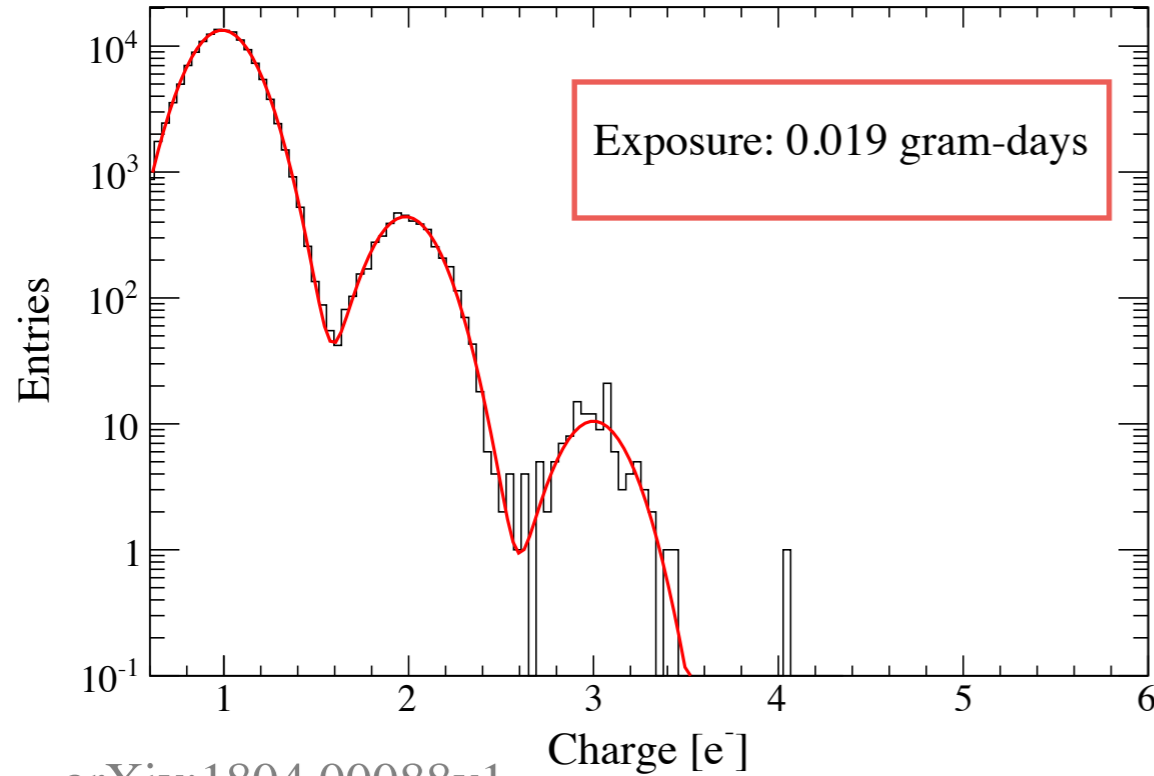
typical
recoil energy

Target materials for electron recoils

| Target Type | Examples | E_{th} | m_χ threshold | Status | Timescale |
|-----------------|---------------------|-----------------|--------------------|---|----------------------|
| Noble liquids | Xe, Ar, He | ~ 10 eV | ~ 5 MeV | Done w data; improvements possible | existing |
| Semi-conductors | Ge, Si | ~ 1 eV | ~ 200 keV | ($E_{\text{th}} \sim 40$ eV SuperCDMS, DAMIC) $E_{\text{th}} \sim 1$ eV SENSEI , DEPFET R&D | ~ 1 -2 years |
| Scintillators | GaAs, NaI, CsI, ... | ~ 1 eV | ~ 200 keV | R&D required | $\lesssim 5$ years |
| Superfluid | He | ~ 1 eV | ~ 1 MeV | R&D required unknown background | $\lesssim 5$ years |
| Super-conductor | Al | ~ 1 meV | ~ 1 keV | R&D required unknown background | $\sim 10 - 15$ years |

arXiv:1608.08632

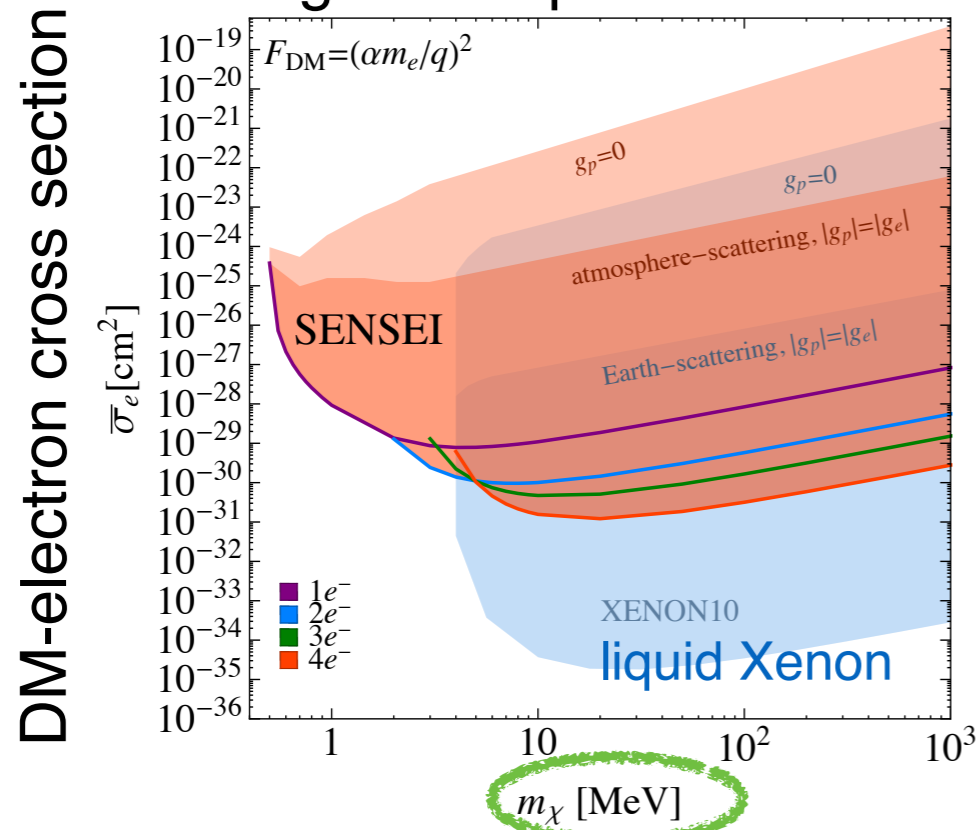
SENSEI first result with “skipper” CCD



arXiv:1804.00088v1

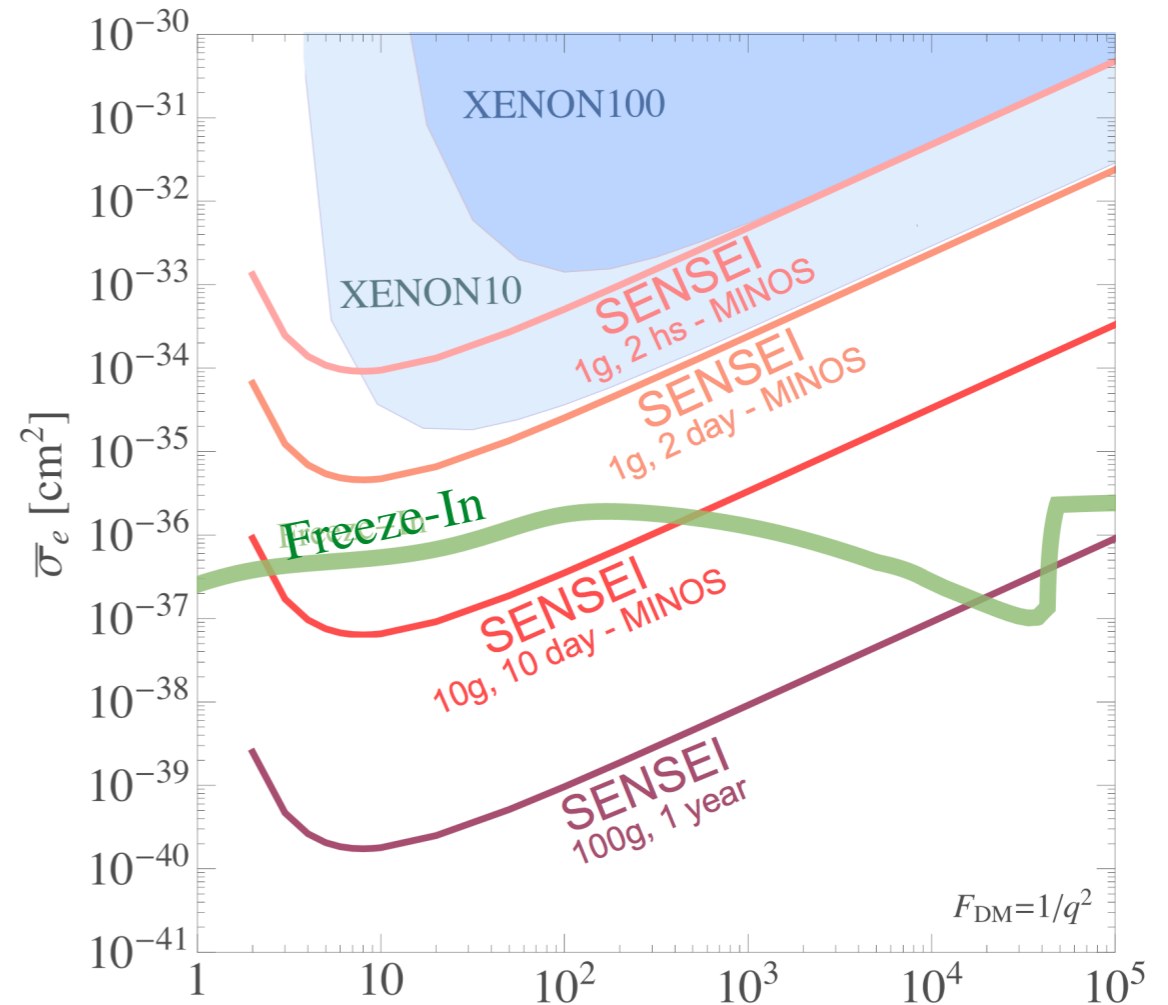
Active mass : 0.071 grams
 427 minutes exposure (0.33 g-hr)
 above sea level 220 m
 single read noise : $\sim 4 e^-$
effective noise : $\sim 0.14 e^-$ (800 repetitions)
dark current : $\sim 1.14 e^-/\text{pixel}/\text{day}$
 assume all events DM induced
 -> conservative limit

ultralight dark photon mediator



arXiv:1804.00088v1

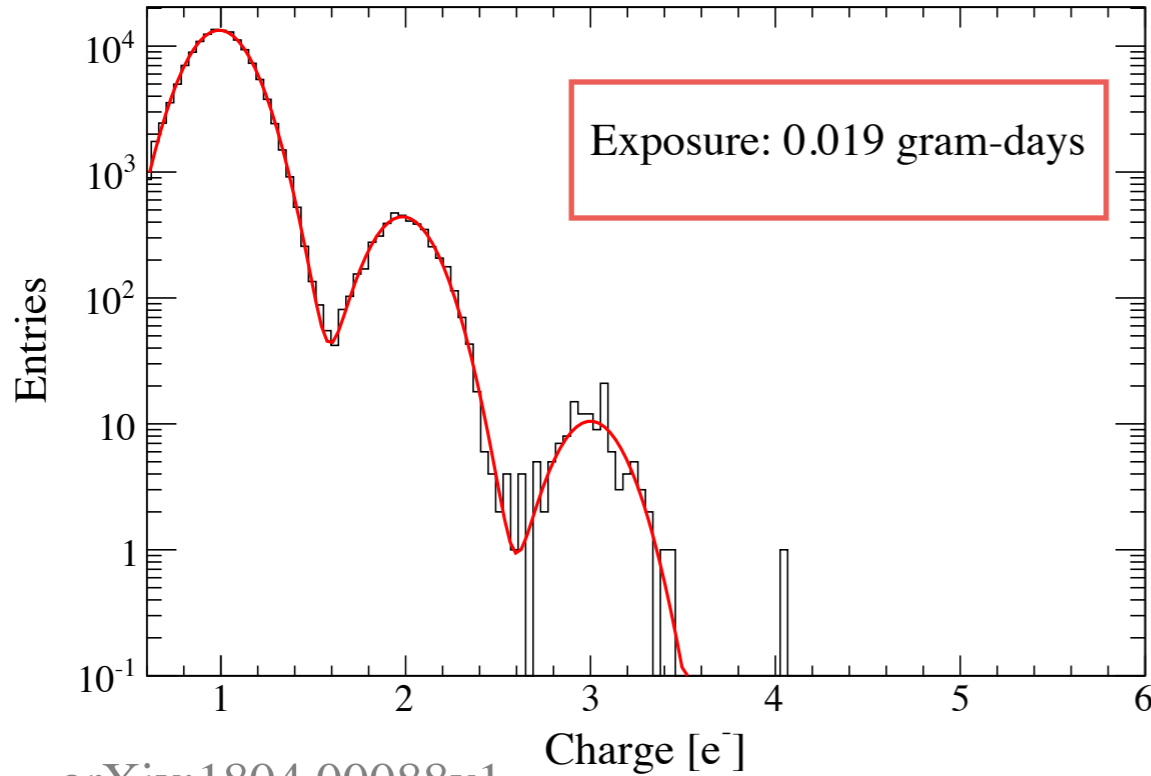
DM-electron cross section



10

$m_\chi [\text{MeV}]$ from SENSEI homepage

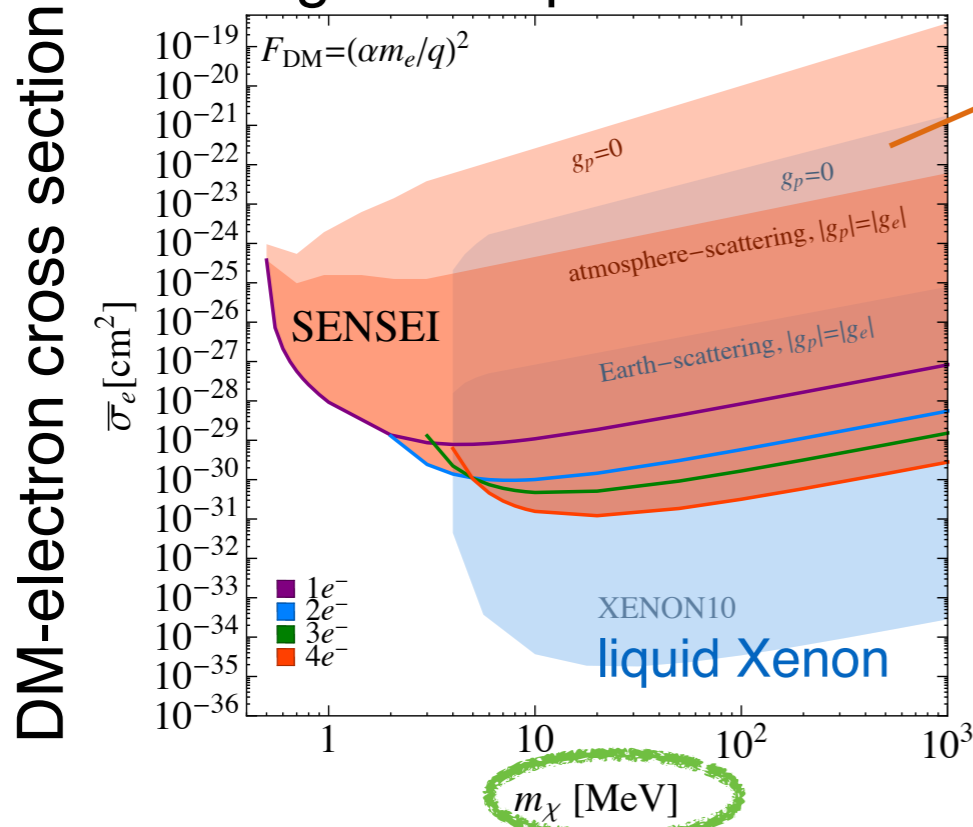
SENSEI first result with “skipper” CCD



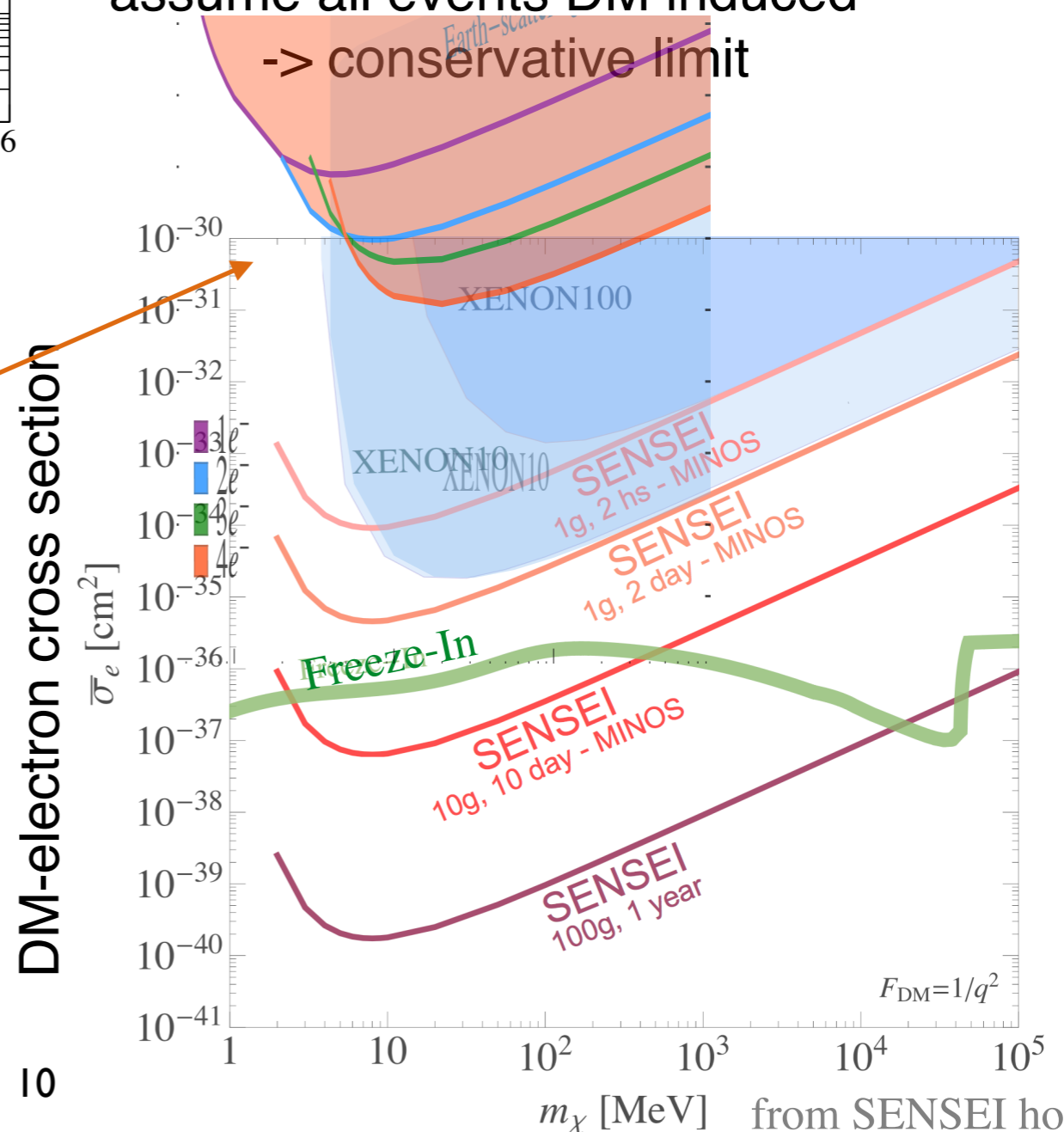
arXiv:1804.00088v1

Active mass : 0.071 grams
 427 minutes exposure (0.33 g-hr)
 above sea level 220 m
 single read noise : $\sim 4 e^-$
effective noise : $\sim 0.14 e^-$ (800 repetitions)
dark current : $\sim 1.14 e^-/\text{pixel}/\text{day}$
 assume all events DM induced

ultralight dark photon mediator



arXiv:1804.00088v1



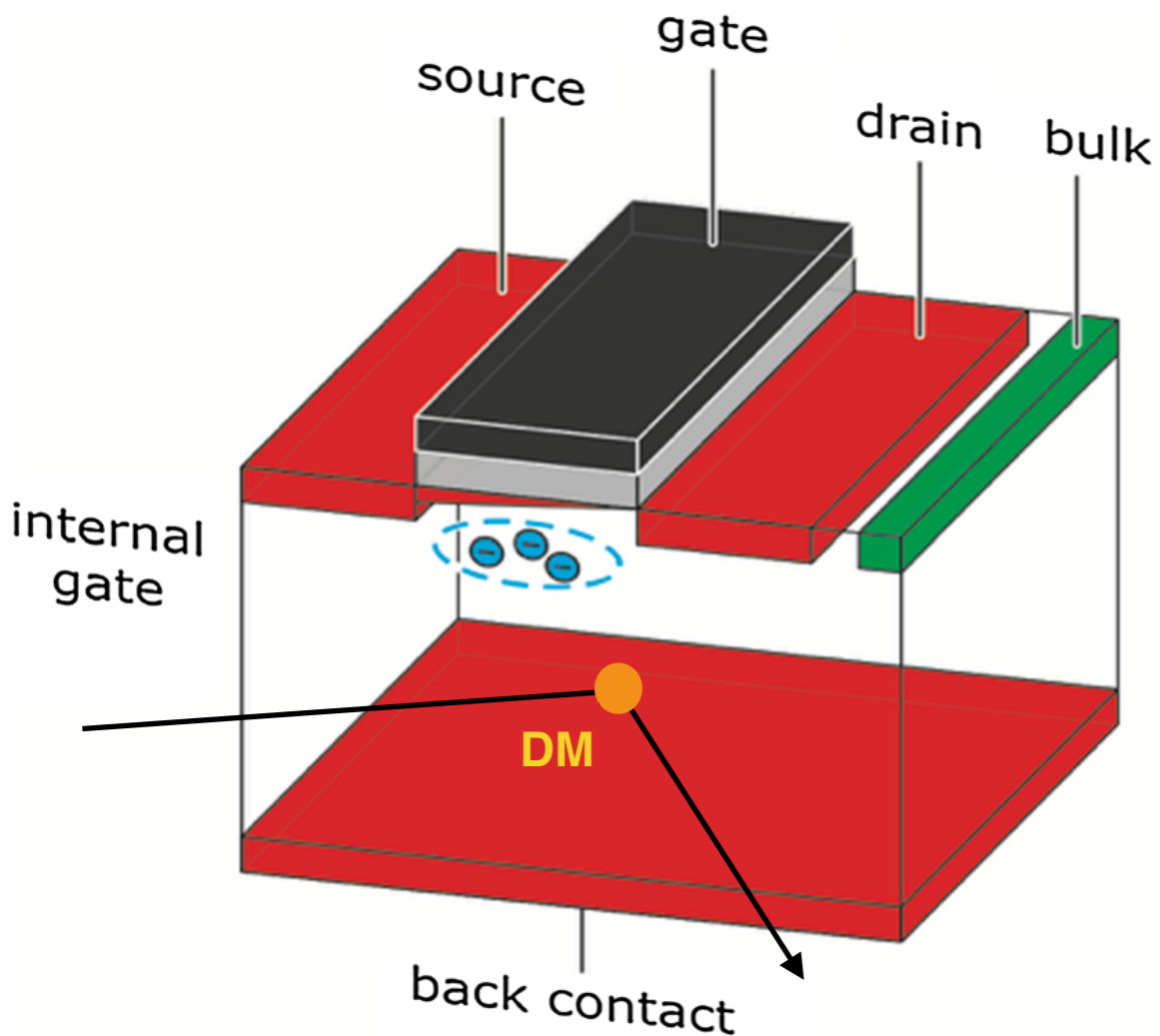
10

from SENSEI homepage

DEPFET with RNDR

RNDR : repetitive non-destructive readout

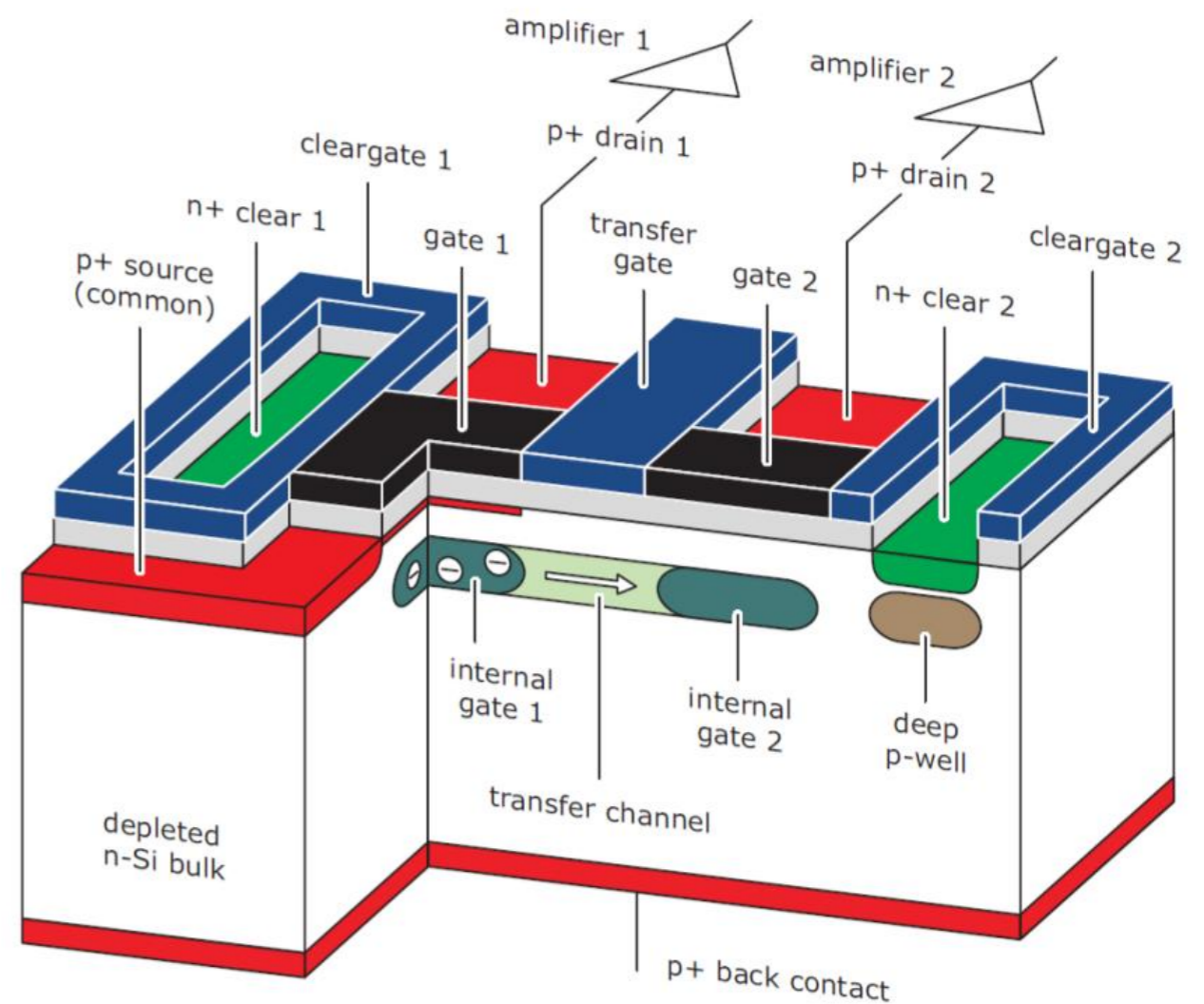
structure of a basic DEPFET cell :
a “subpixel”



EPJ C, 77(12), 279 (2017)

fully-depleted n-Si

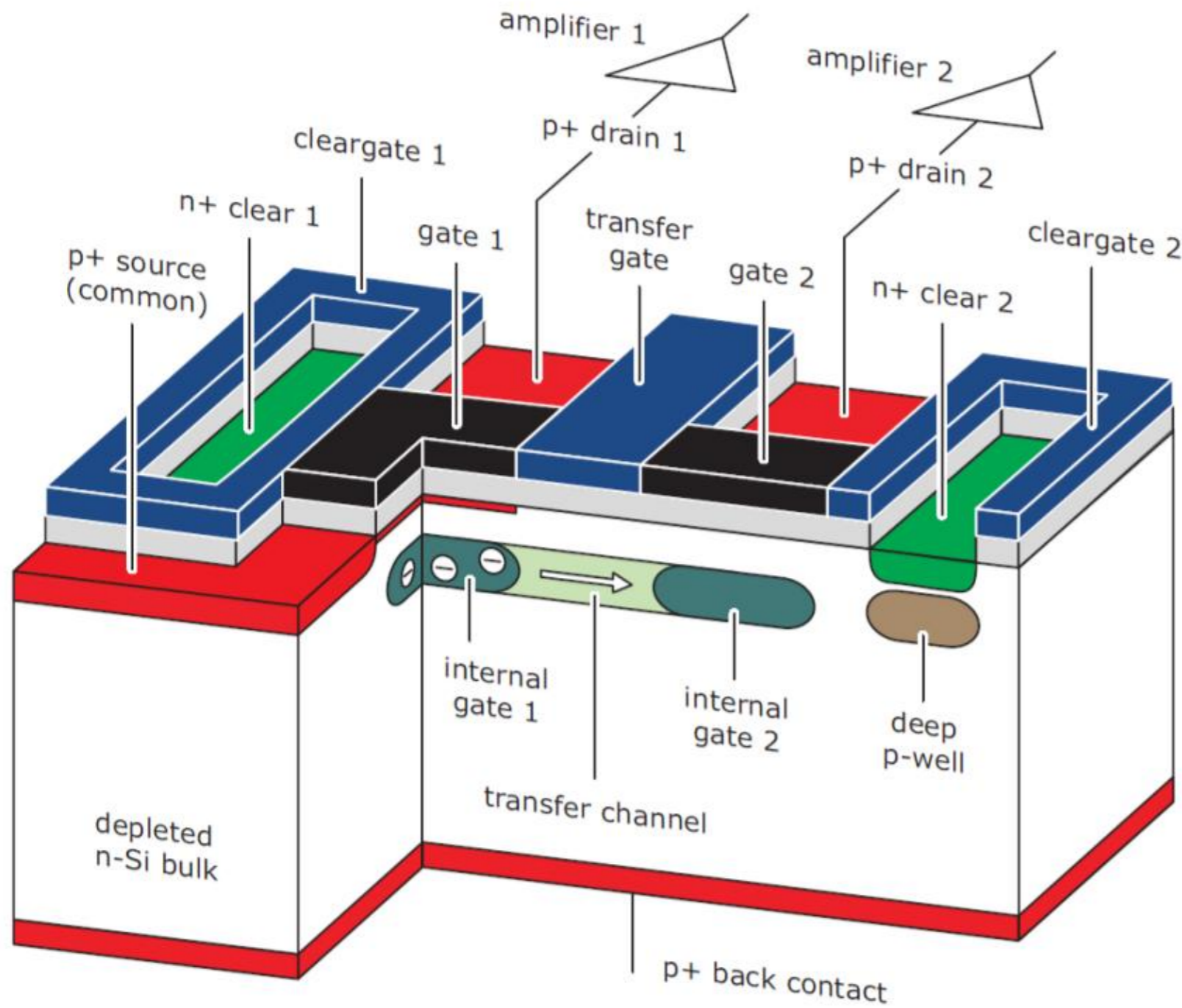
structure of RNDR DEPFET “super-pixel”



EPJ C, 77(12), 279 (2017)

RNDR

RNDR readout

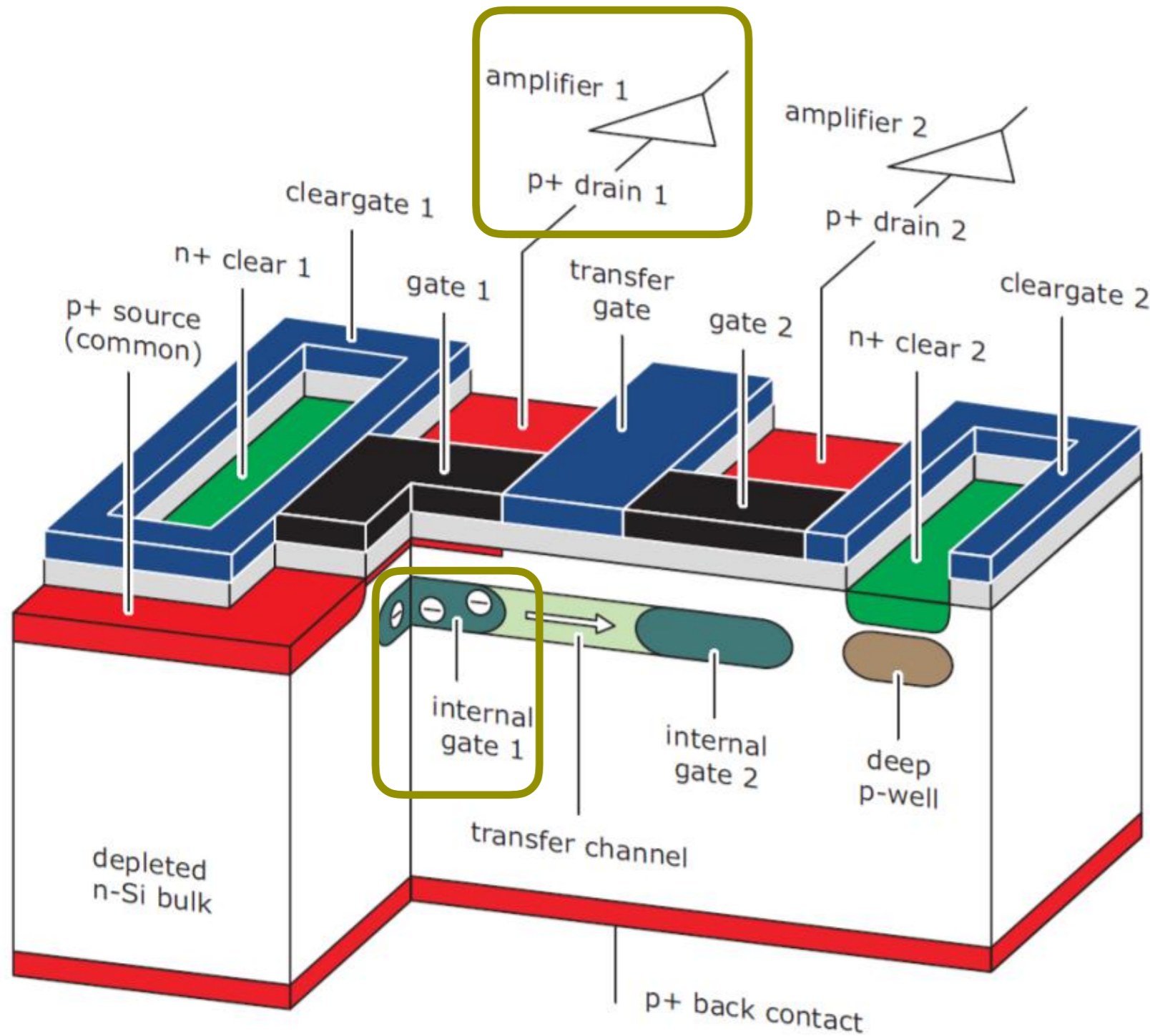


EPJ C, 77(12), 279 (2017)

read N times effective noise :

$$\sigma_{\text{eff}} = \sigma / (\sqrt{N})$$

RNDR



RNDR readout

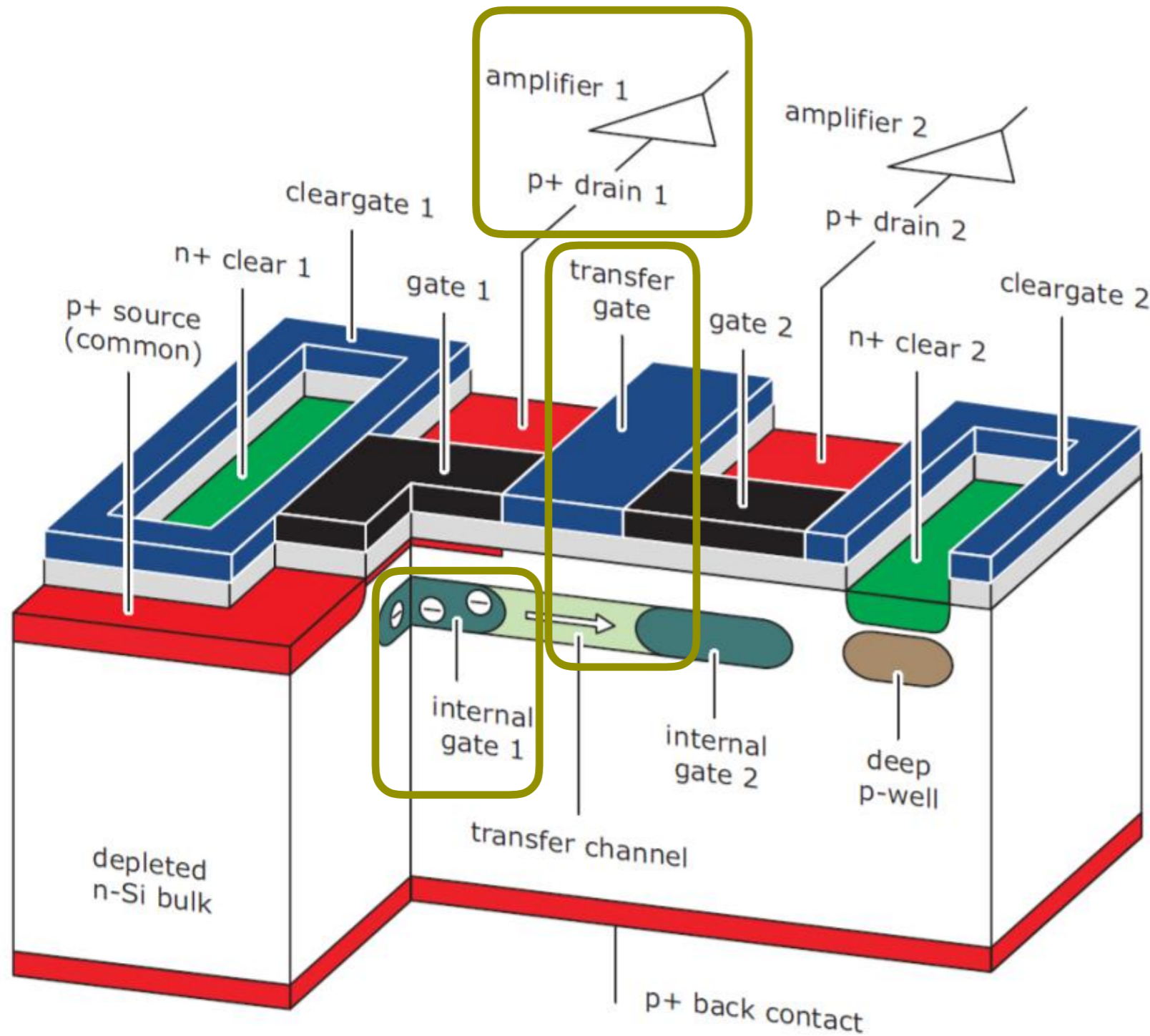
read **1** : noise σ

EPJ C, 77(12), 279 (2017)

read N times effective noise :

$$\sigma_{\text{eff}} = \sigma / (\sqrt{N})$$

RNDR



RNDR readout

read **1** : noise σ



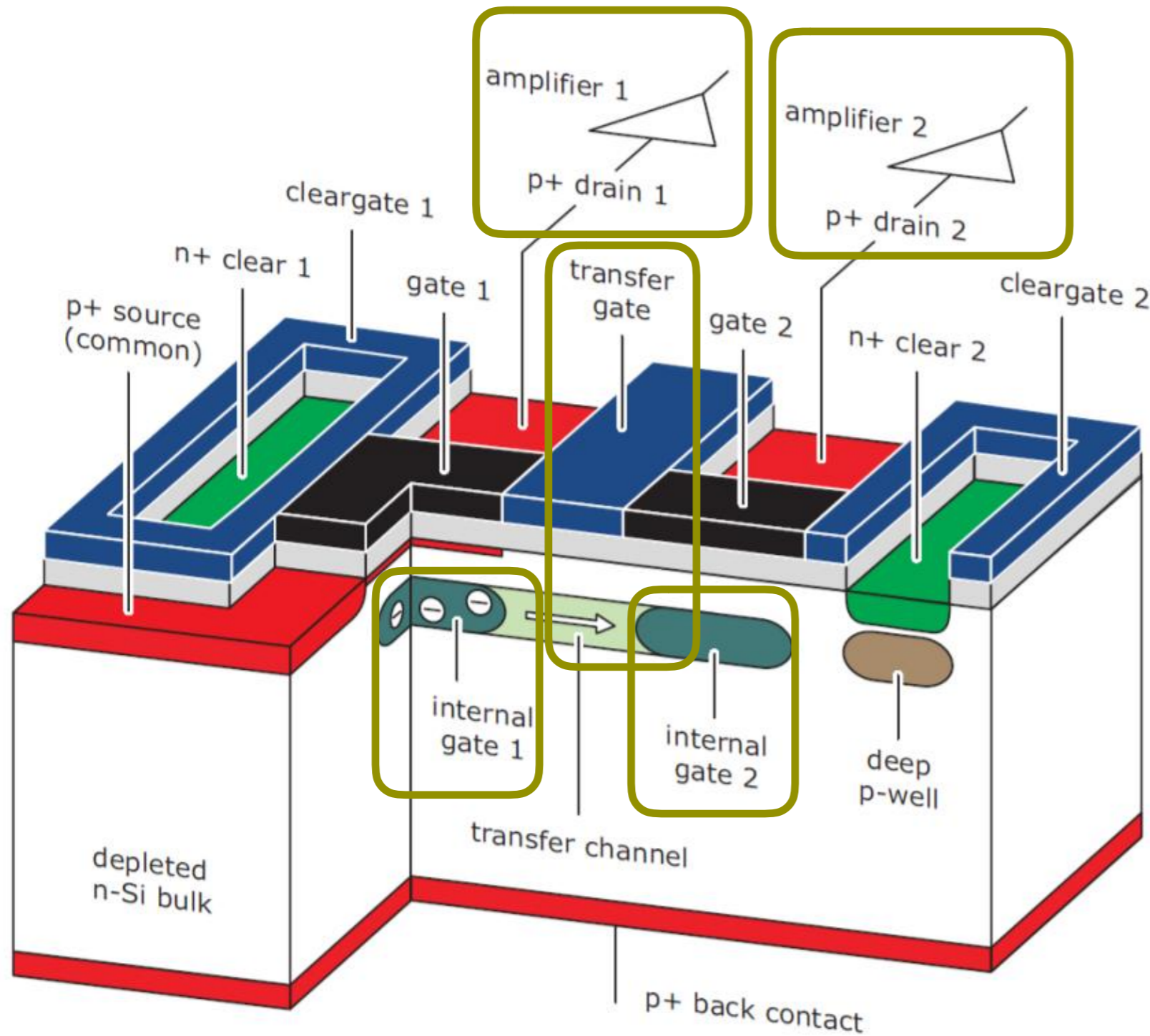
transfer gate open

EPJ C, 77(12), 279 (2017)

read N times effective noise :

$$\sigma_{\text{eff}} = \sigma / (\sqrt{N})$$

RNDR



RNDR readout

read **1** : noise σ



transfer gate open



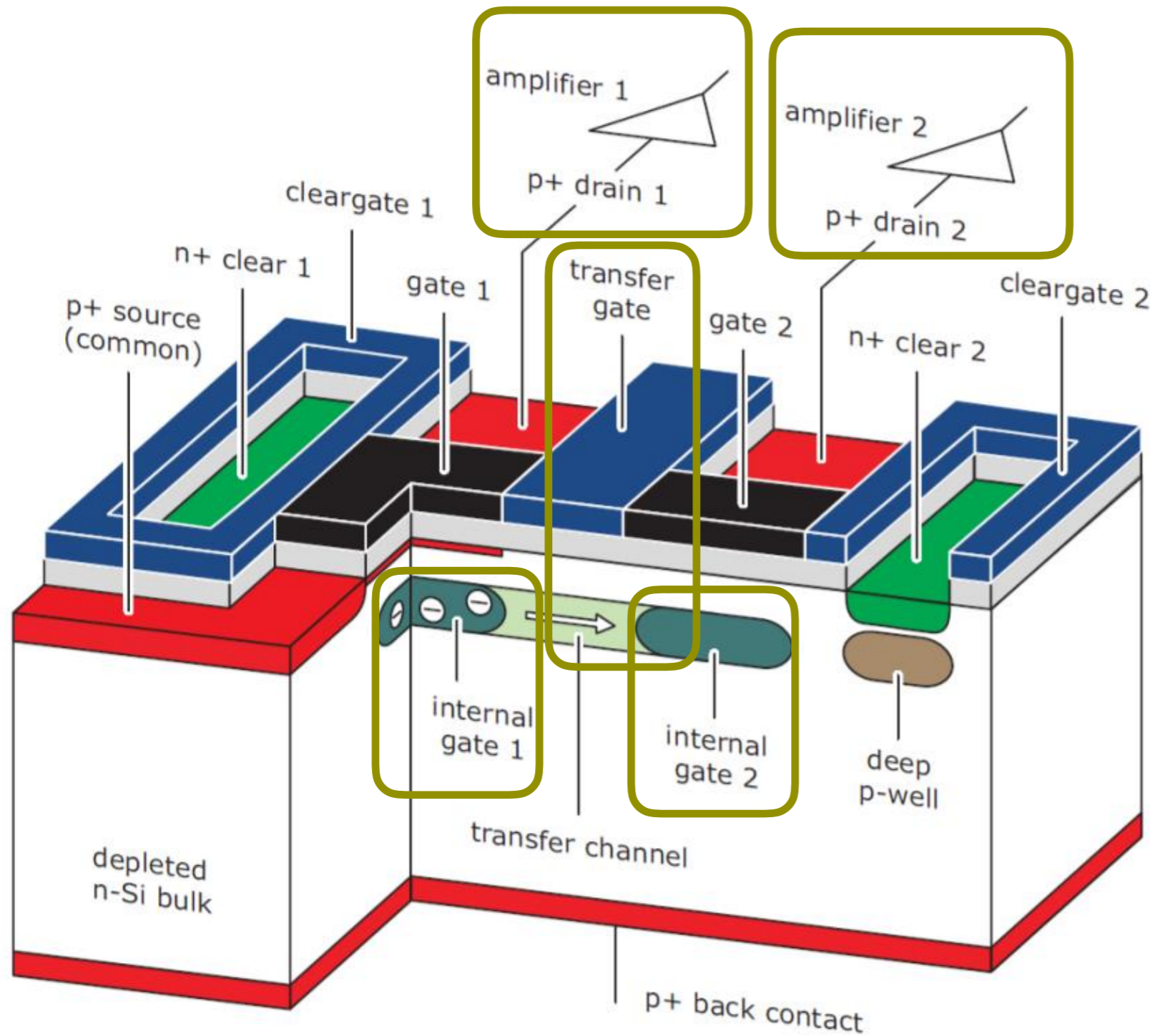
read **2** : noise σ

EPJ C, 77(12), 279 (2017)

read N times effective noise :

$$\sigma_{\text{eff}} = \sigma / (\sqrt{N})$$

RNDR



EPJ C, 77(12), 279 (2017)

RNDR readout

read **1** : noise σ



transfer gate open



read **2** : noise σ

: repeat **N** times
independent
measurements



clear charges

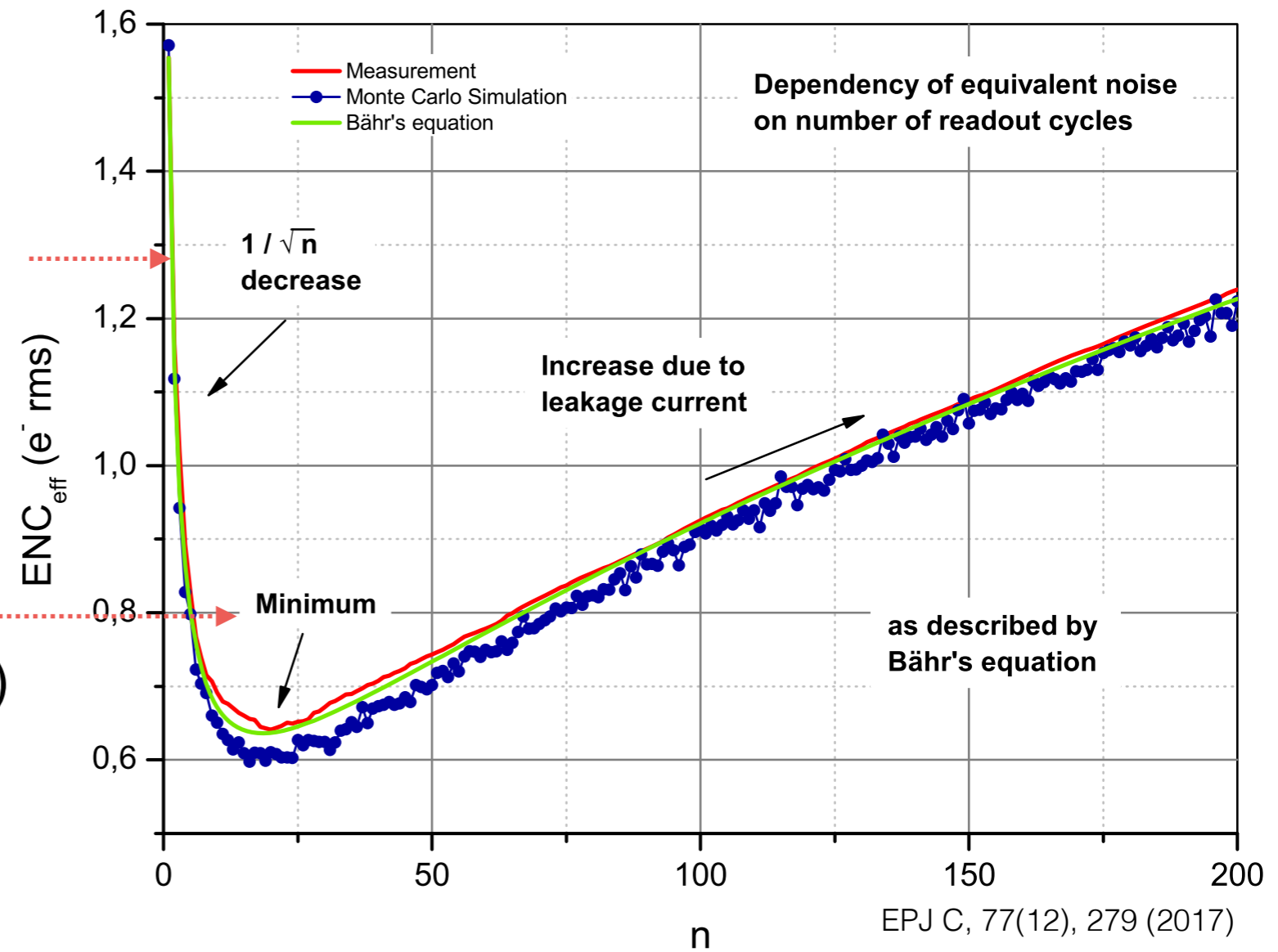
read N times effective noise :

$$\sigma_{\text{eff}} = \sigma / (\sqrt{N})$$

DEPFET RNDR single pixel performance

confirmed the $1/\sqrt{N}$ decrease of σ_{eff}

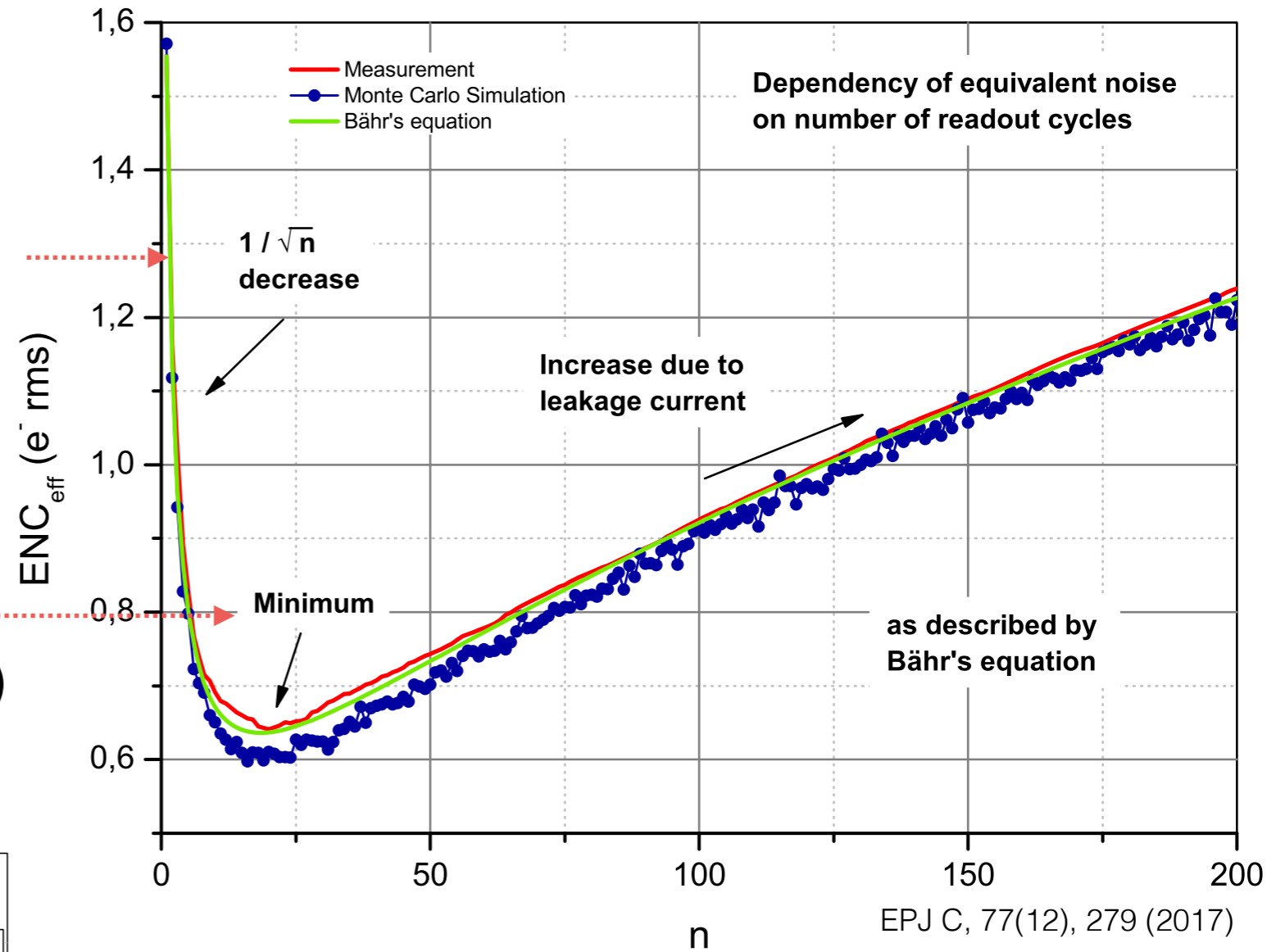
minimal noise level limited by leakage current at 230 K (-40 °C)



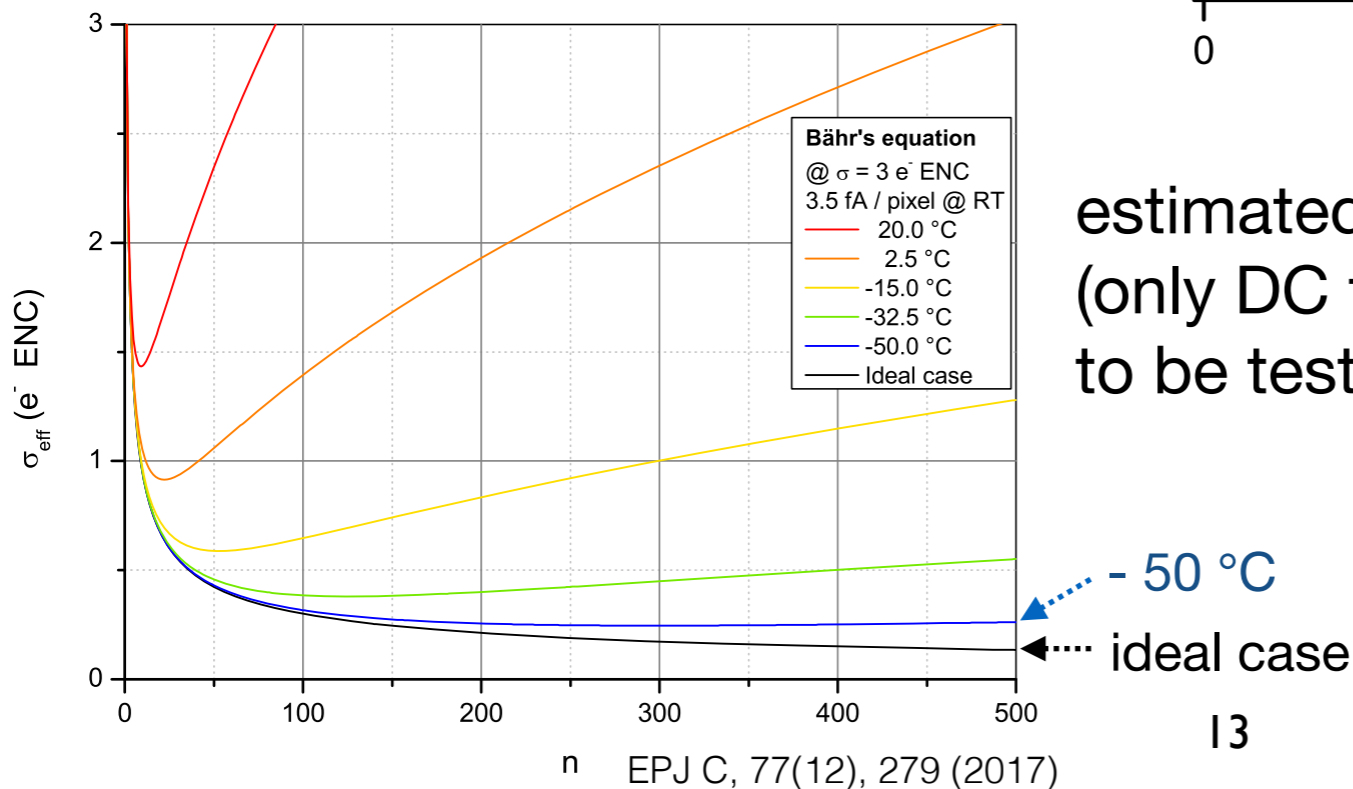
DEPFET RNDR single pixel performance

confirmed the $1/\sqrt{N}$ decrease of σ_{eff}

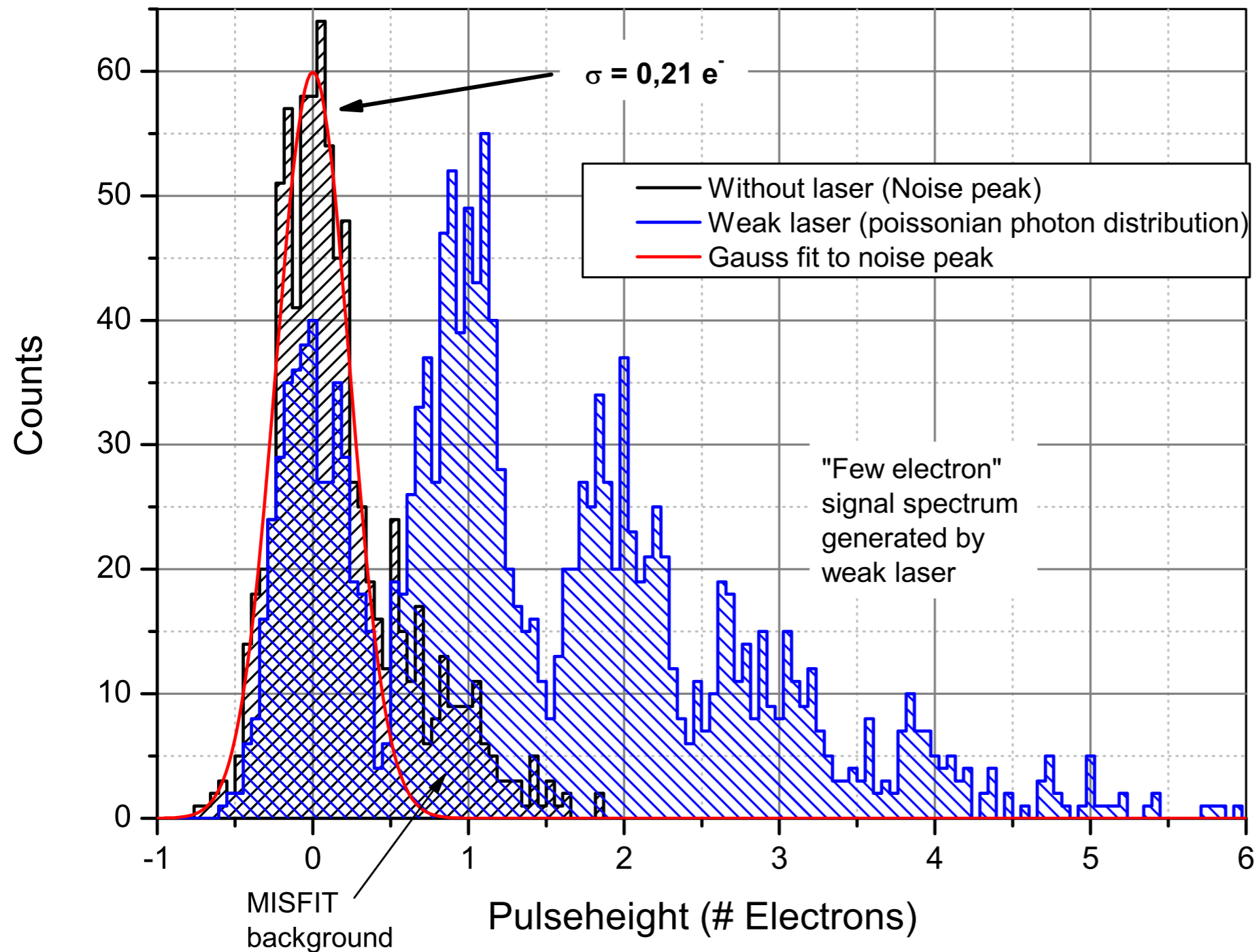
minimal noise level limited by leakage current at 230 K (-40 °C)



estimated temperature dependence (only DC from thermal excitation) to be testified in measurement



DEPFET RNDR single pixel performance

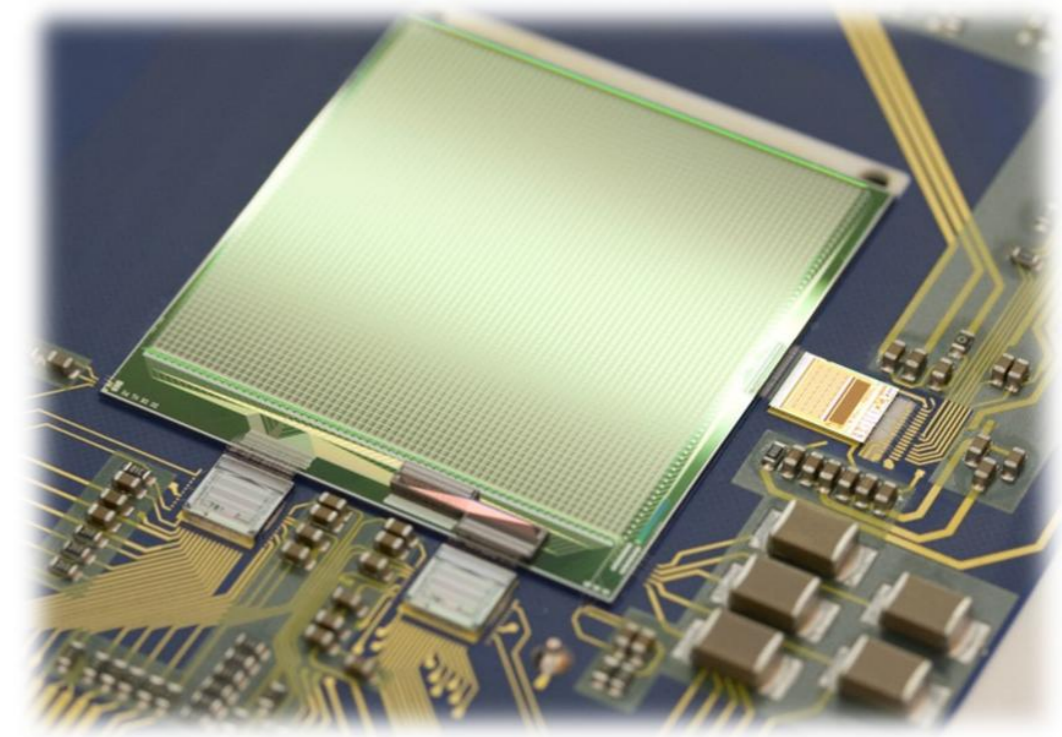
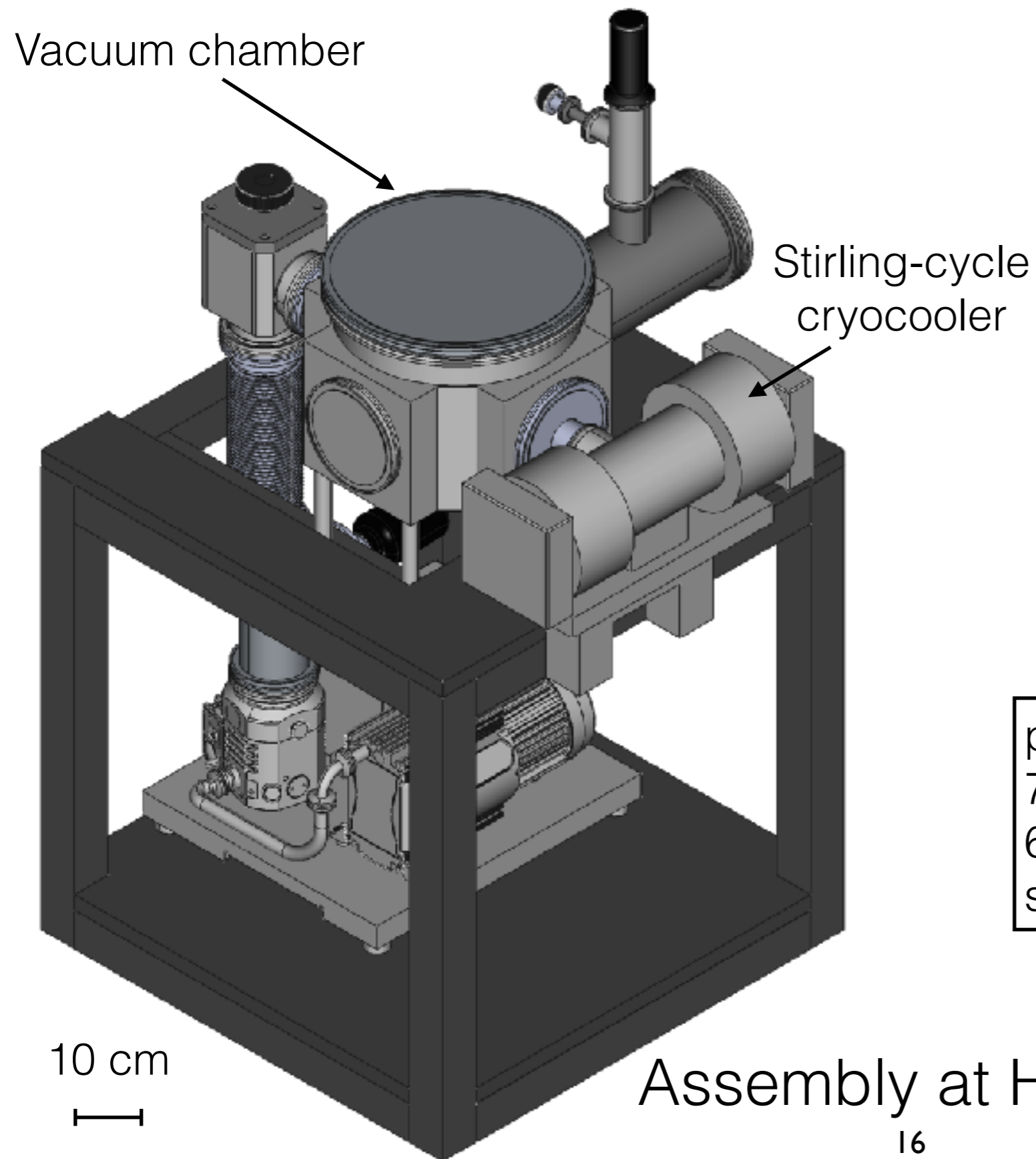


A comparison with skipper CCD

| Type | Pixel format [μm] | prototype mass | operating temp | dark current | readout time (1 sample) | readout noise (optimal) |
|-------------|-------------------|----------------|----------------|--|-------------------------|-------------------------|
| skipper CCD | 15 x 15 x 200 | 0.071 g | 140 K | $\leq \sim 1.14$ <u>e⁻/pix/day</u> | 10 μs/pix/ amplifier | 0.068 e-rms/pix |
| RNDR DEPFET | 75 x 75 x 450 | 0.024 g | ≈ 200 K | ≤ 1 <u>e⁻/pix/day</u> | 4 μs/ 64 pix | 0.2 e-rms/pix |

similar concepts of non-destructive readout, compatible performance;
different architecture, different systematics;
-> good complementary from experimental point of view

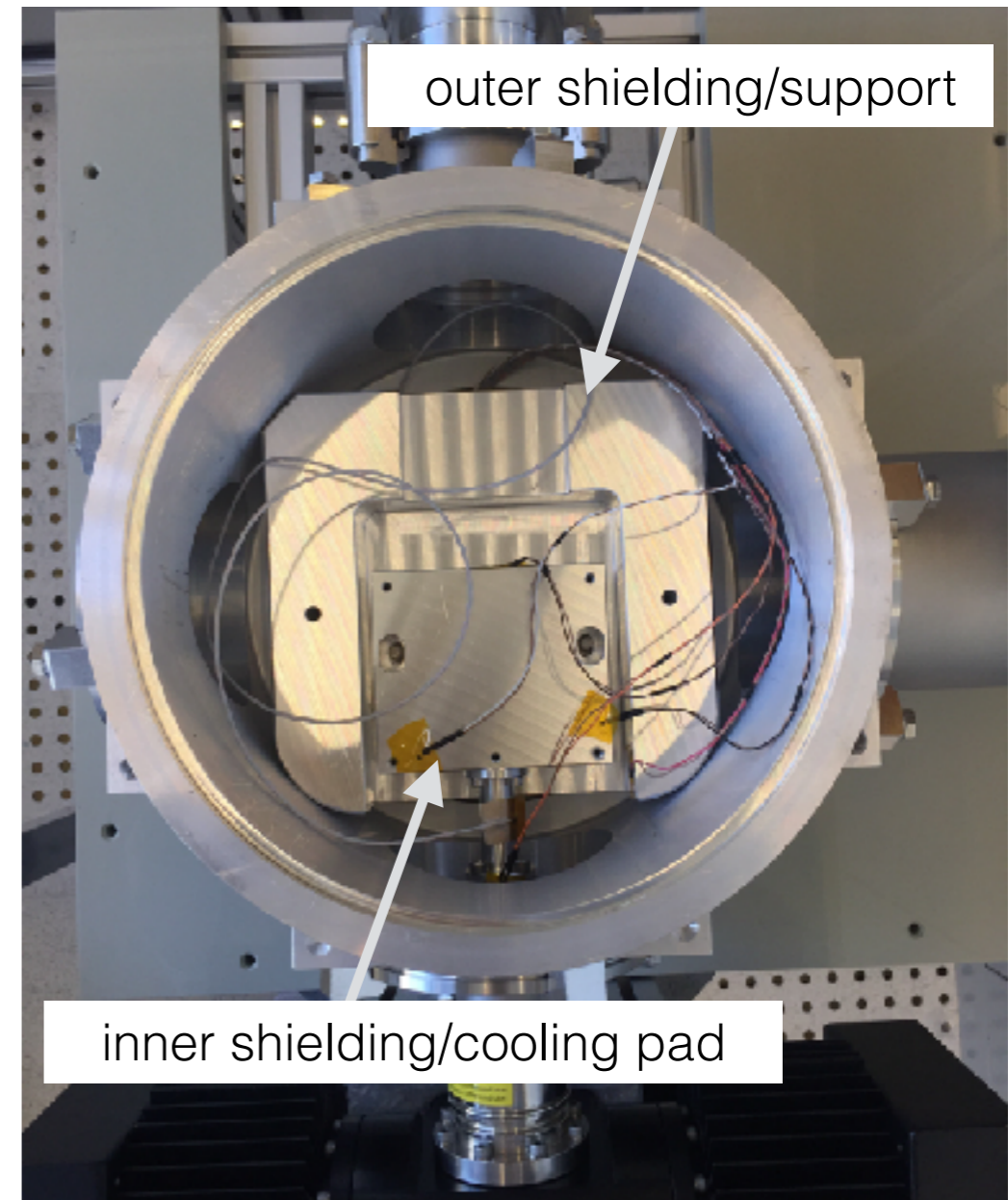
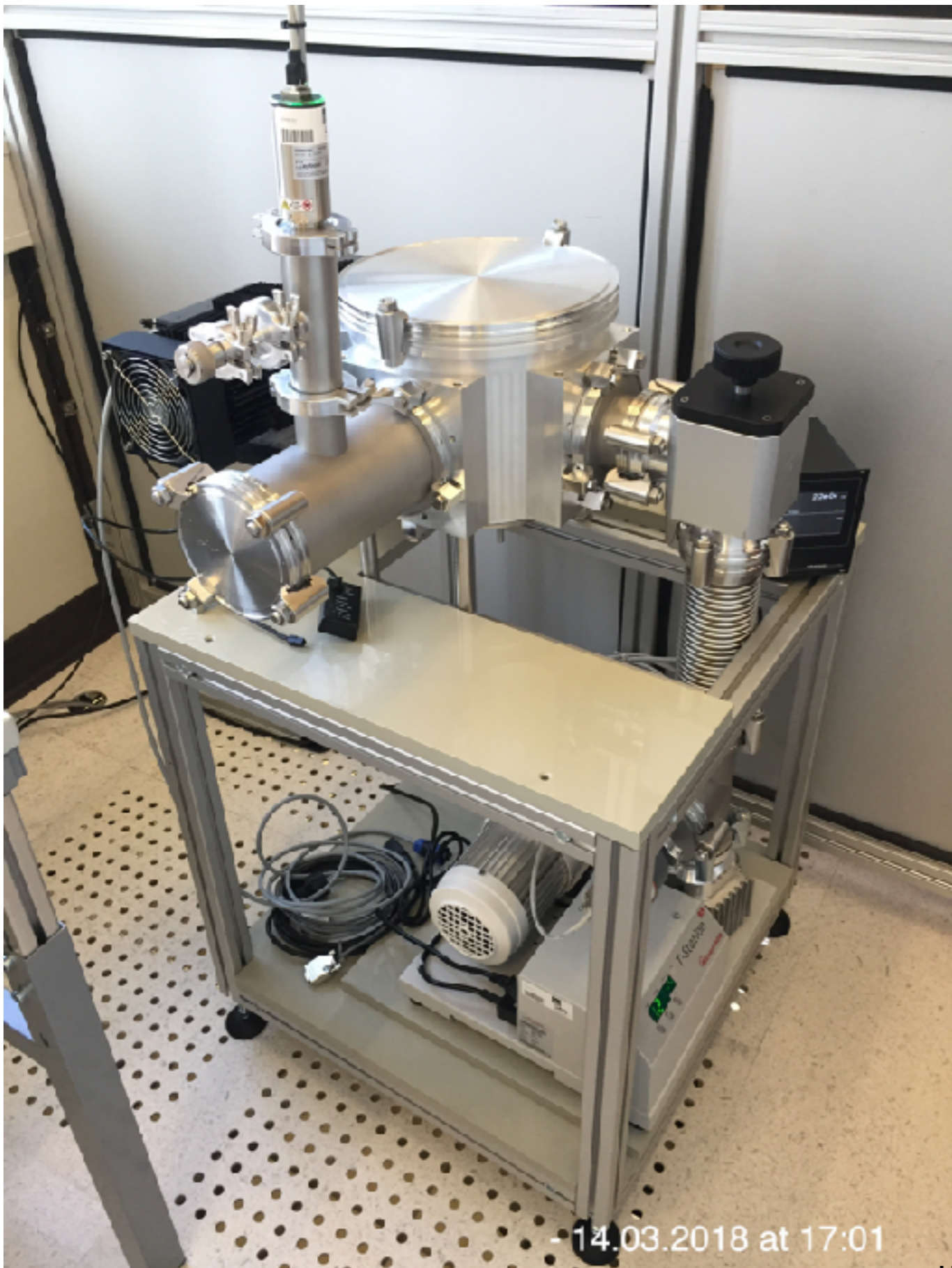
DANAЕ prototype test setup



Detector prototype at HLL-MPG
courtesy of J. Treis

proto-type :
75 μm x 75 μm x 450 μm single pixel,
64 x 64 matrix
sensitive volume **0.024 g**

Setup at HLL



Vacuum and cooling test in March 2018
cooling pad reached 150 K

Detector control and readout electronics

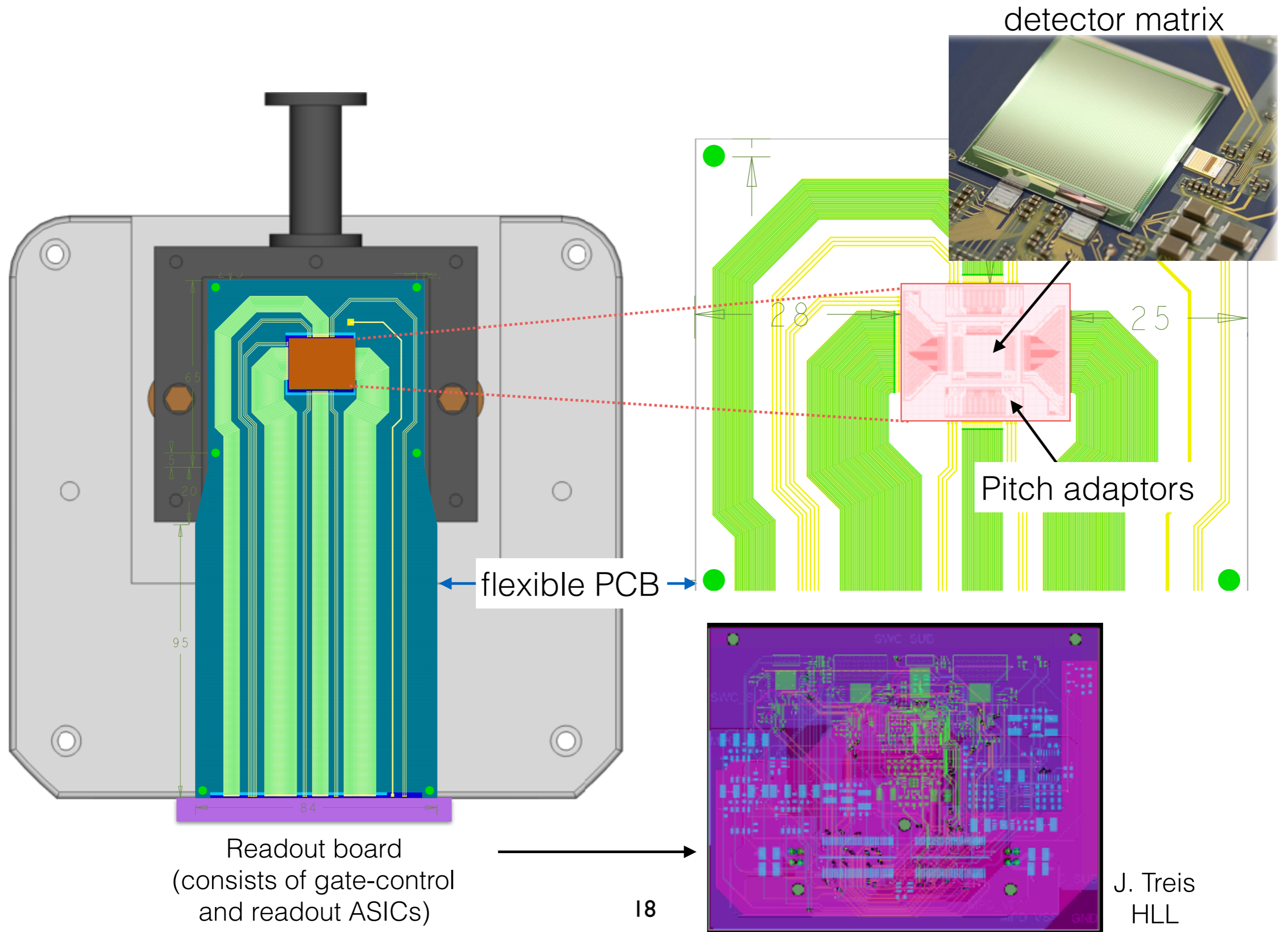
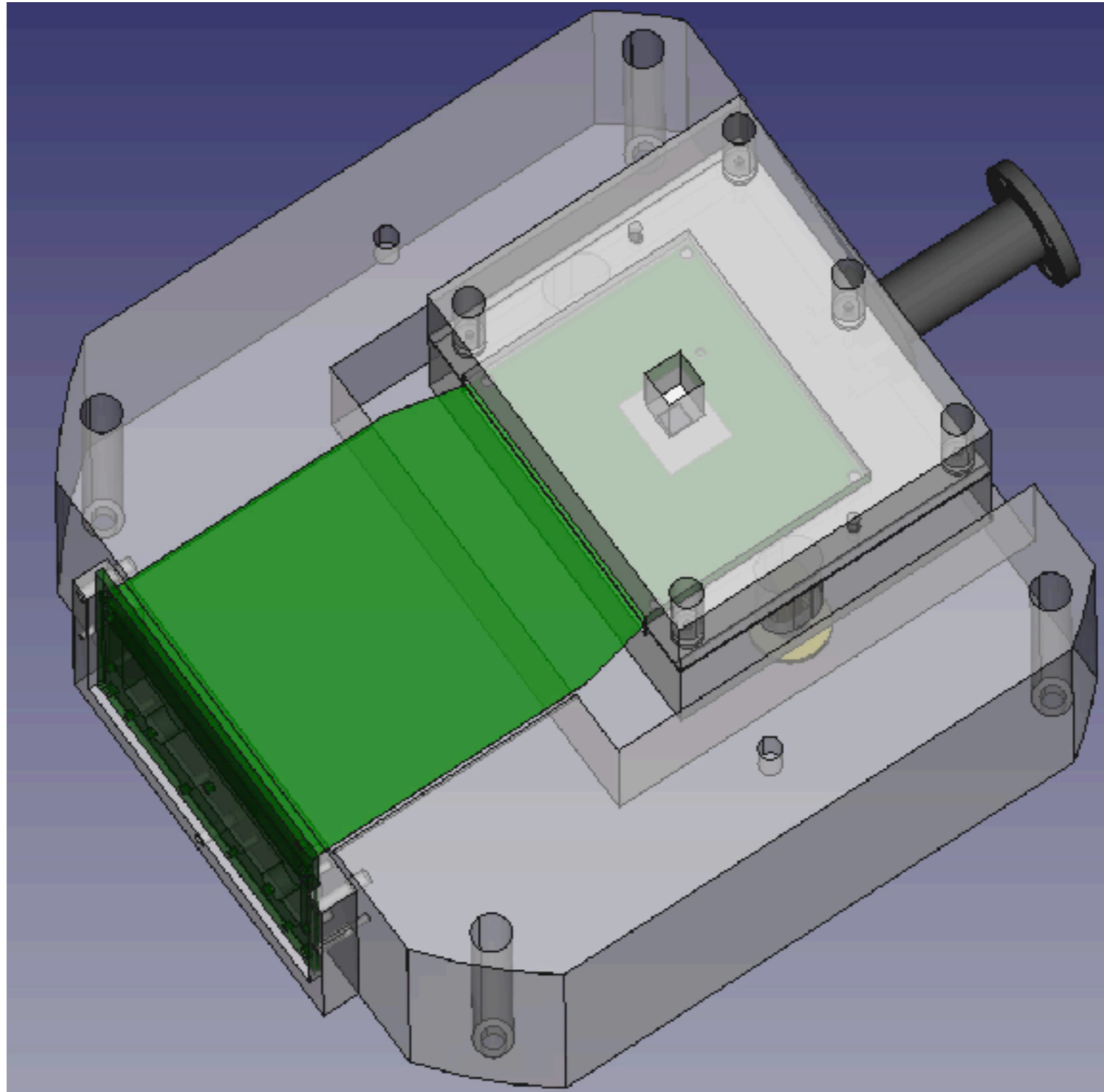


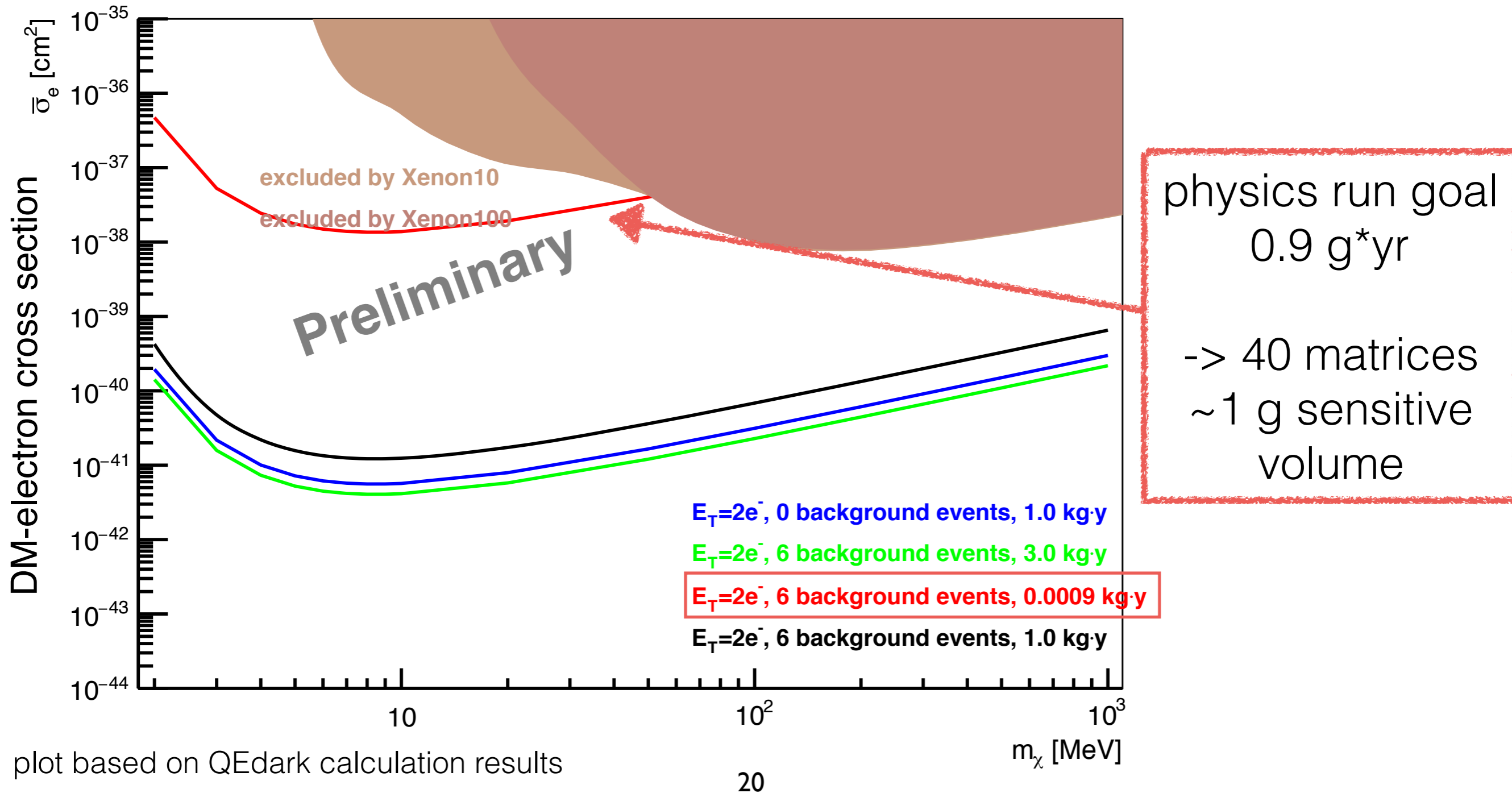
Image of the detector assembly



To be assembled in July-August 2018

Physics run perspective

- Expect preliminary results from the prototype setup (0.024 g sensitive volume) in late 2018
- physics run with significant result requires more matrices



Summary

- sub e^- ENC low noise semiconductor detector capable of detecting the energy deposit from sub-GeV DM-electron recoil;
- DANAE prototype for test-of-principle measurement with 64 x 64 pixel matrix in preparation;
- one of the first generation experiments using non-destructive repetitive readout method.

DANAE (DANAË)

Direct dArk matter search using DEPFET with repetitive- Non-destructive-readout Application Experiment

OeAW funding for detector technology



“Danae” by G. Klimt

Collaboration

A. Bähr ^A, J. Ninkovic ^A, J. Treis ^A,
H. Kluck ^{B,C}, J. Schieck ^{B,C}, H. Shi ^B,

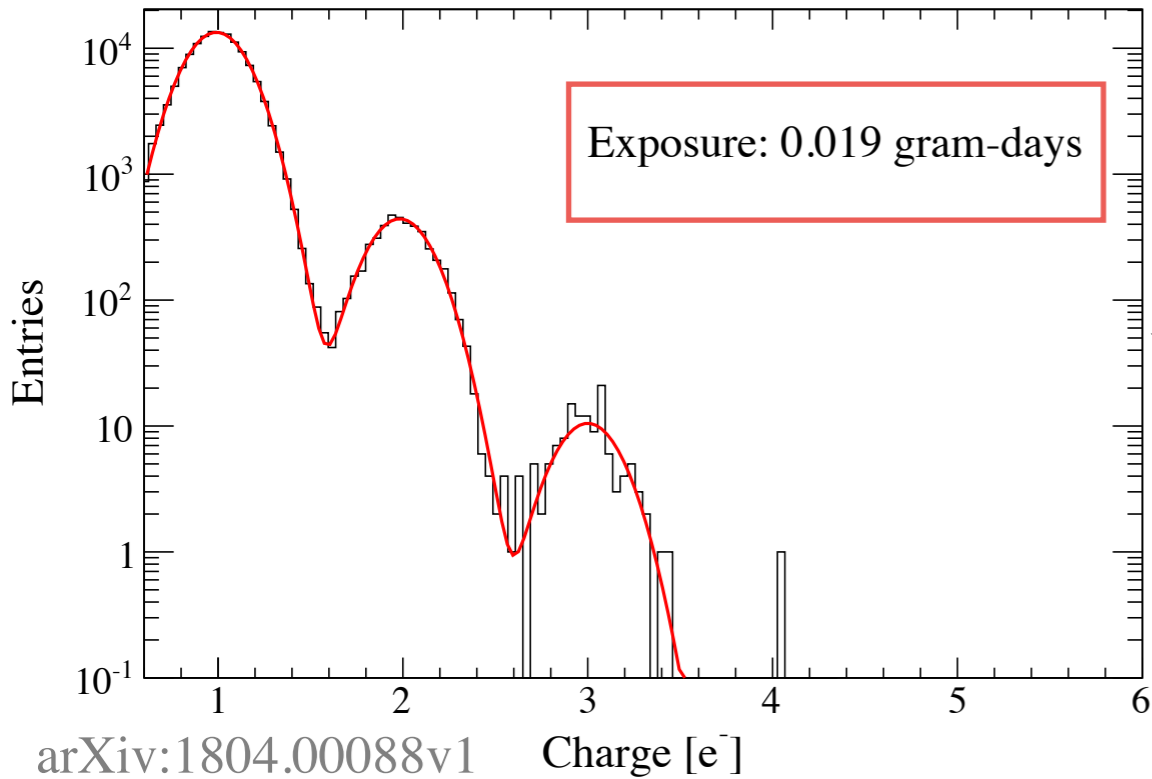


Max-Planck-Gesellschaft Halbleiterlabor, Germany ^A,

Institut für Hochenergiephysik der Österreichischen Akademie der Wissenschaften, Vienna, Austria ^B,

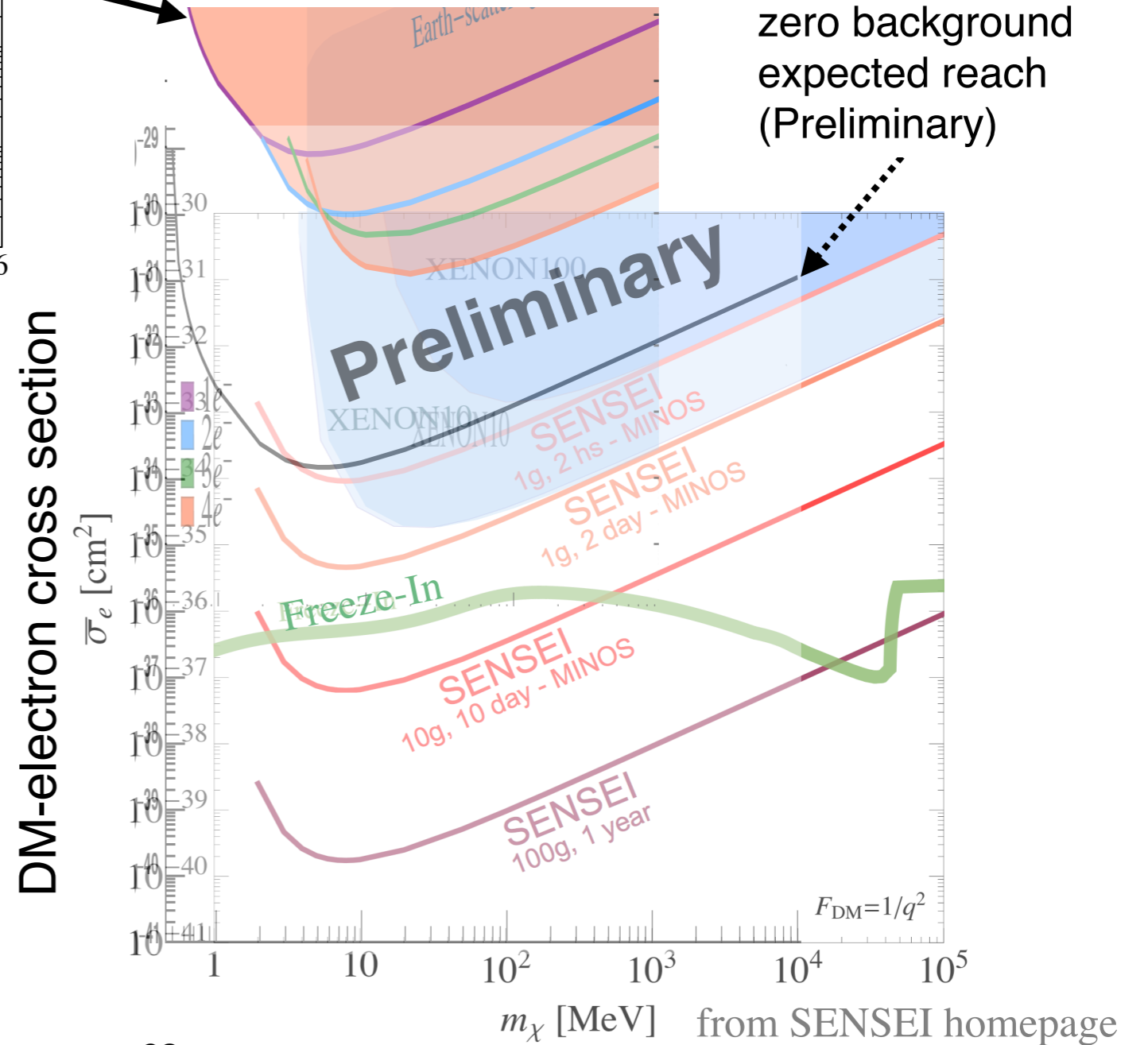
Atominstytut, Technische Universität Wien, Vienna, Austria ^C

Expected 1day exposure compared to SENSEI



SENSEI prototype physics run

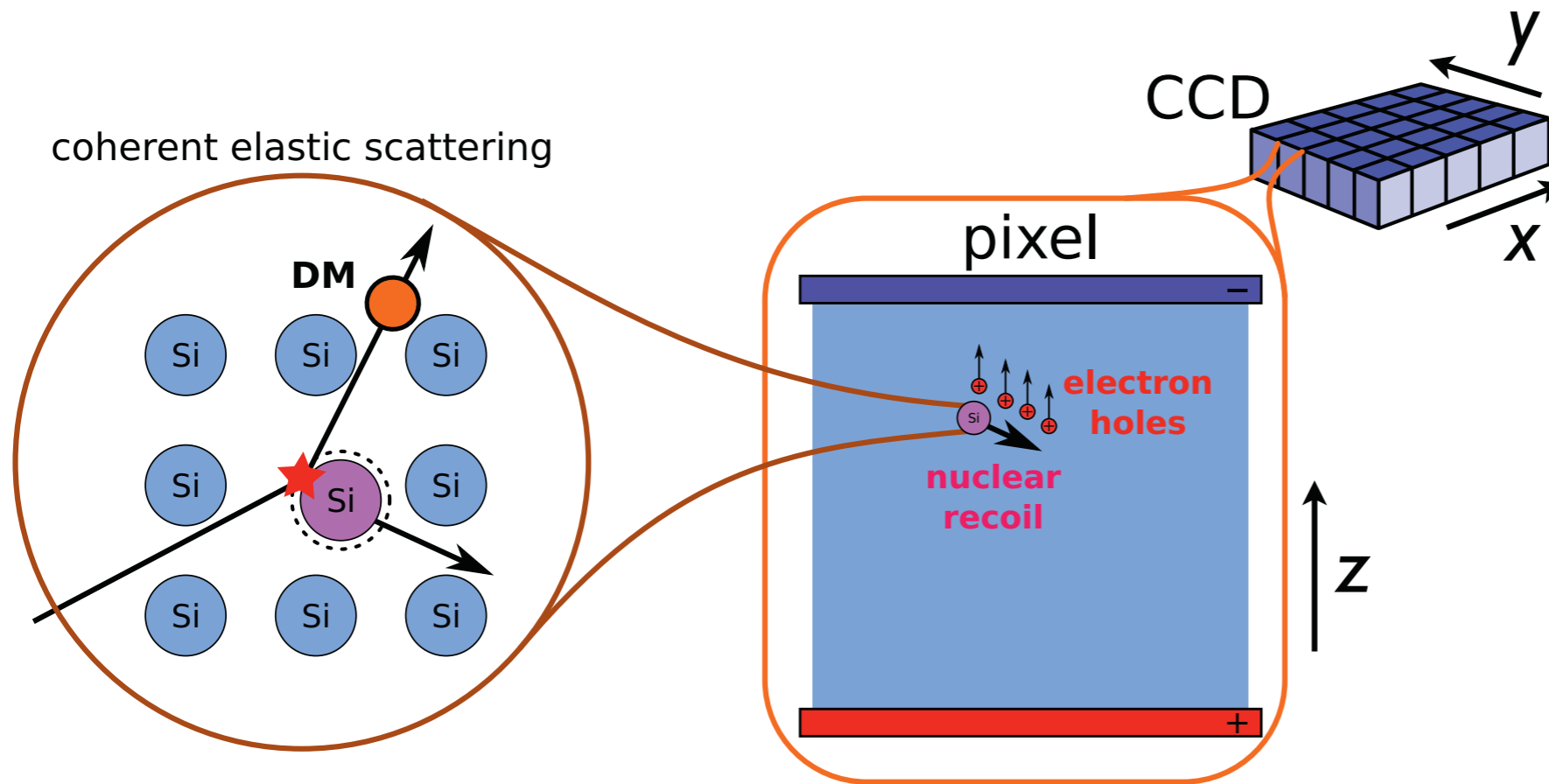
DANAЕ prototype 24 mg one-day exposure zero background expected reach (Preliminary)



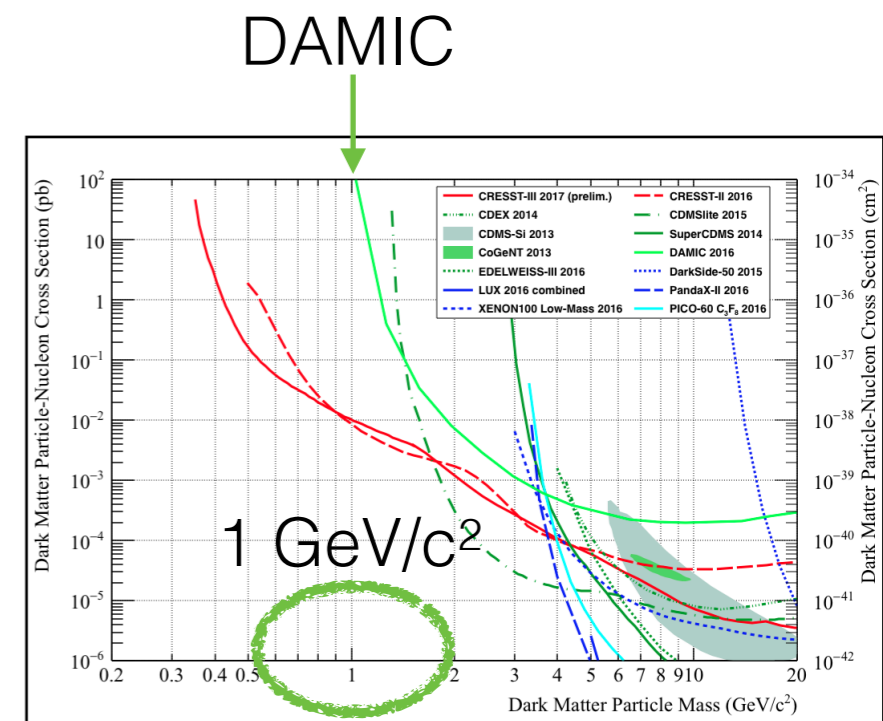
Application of Silicon detector

DAMIC

nucleus recoil CCD, with physics results



Physics Procedia 61 (2015) 21 – 33

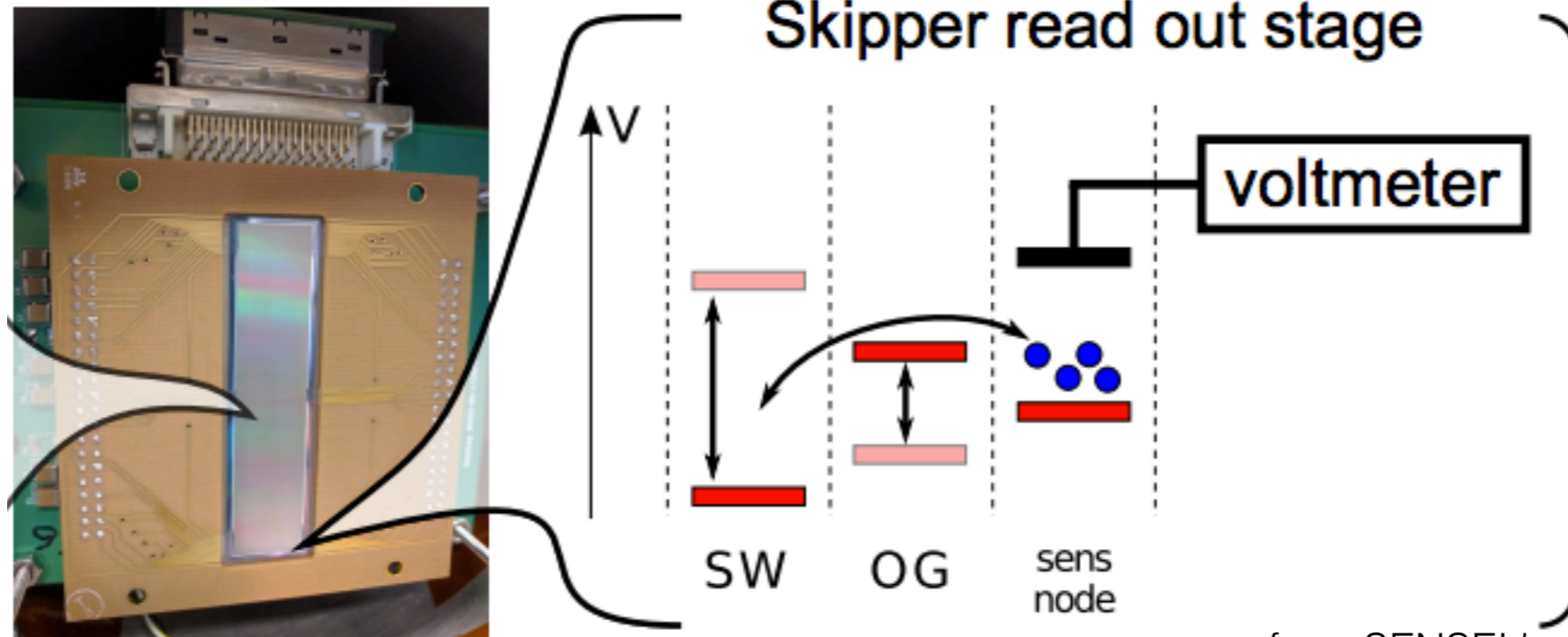


Readout noise determines threshold of $\sim 11 e^-$
(or $\sim 40 eV$)

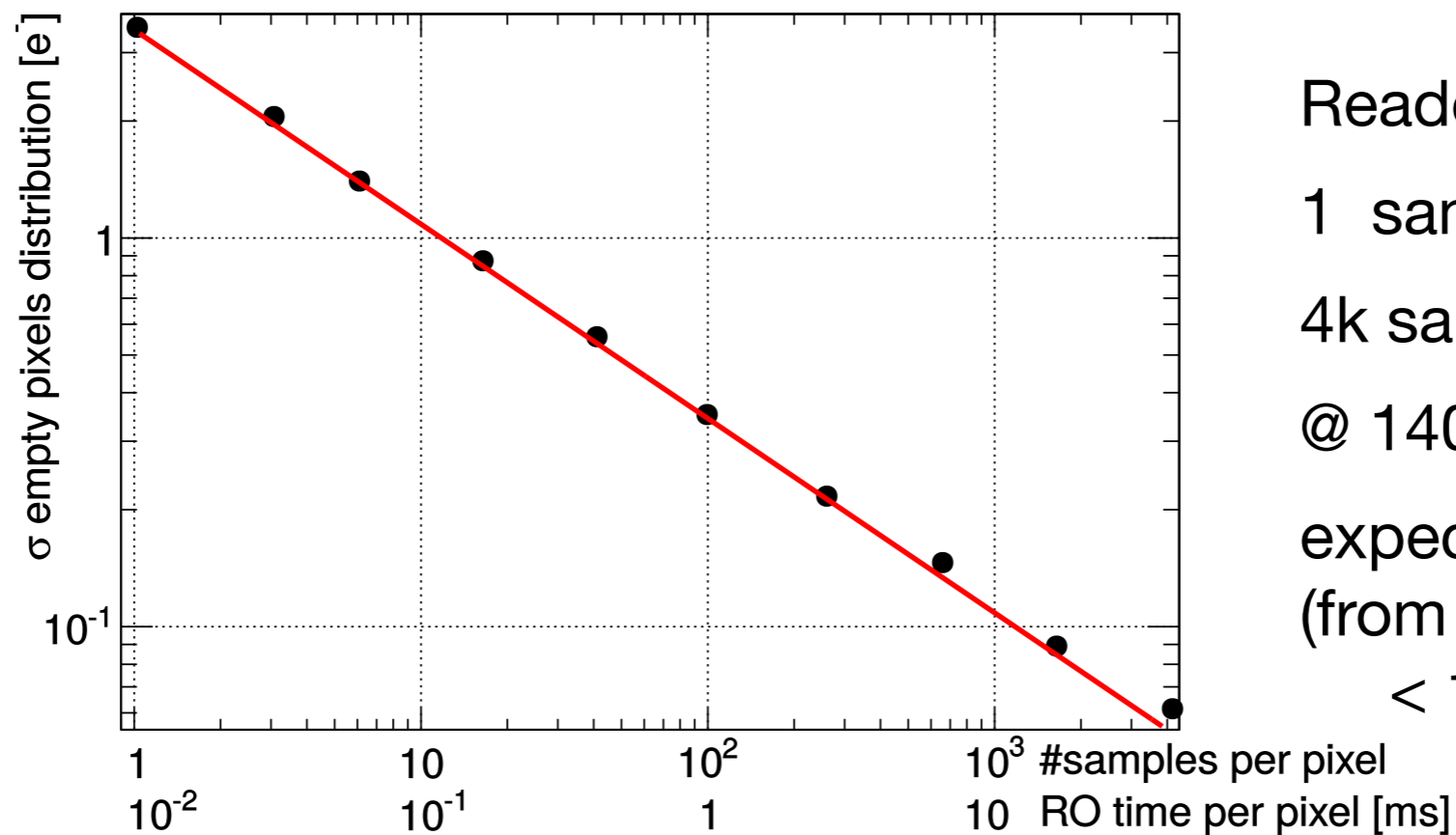
For $O(\text{MeV})$ DM-electron scattering, required threshold : $O(e^-)$
Sub-electron noise level necessary

Skipper CCD for SENSEI

DAMIC CCD with repetitive readout



from SENSEI homepage



Readout noise :

1 sample : 3.55 e^- rms

4k samples : 0.068 e^- rms

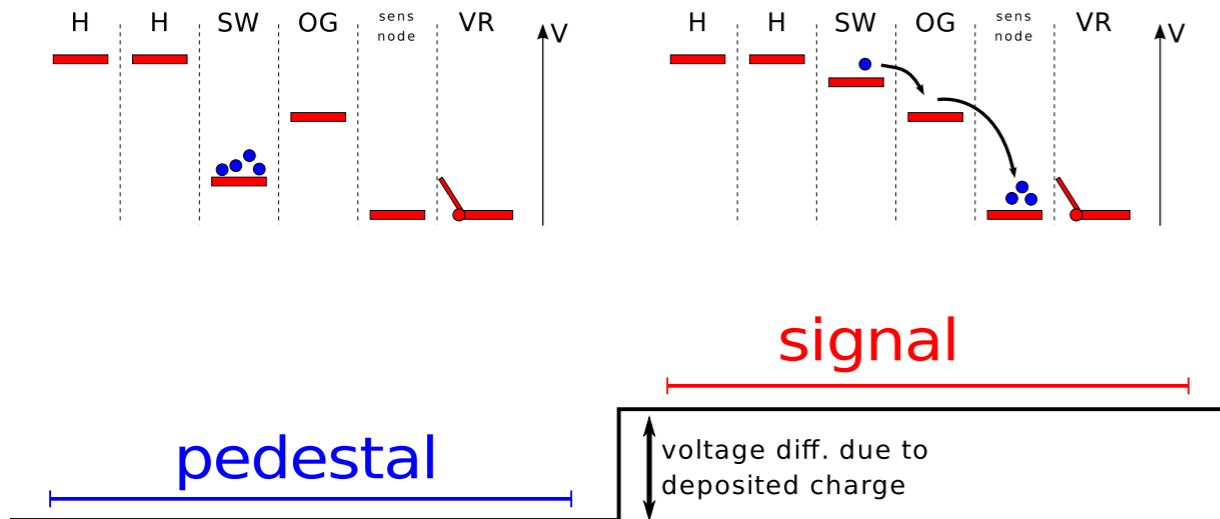
@ 140 K

expected dark current
(from DAMIC CCD) :

< 10^{-3} e^- /pix/day

CCD (skipper) readout

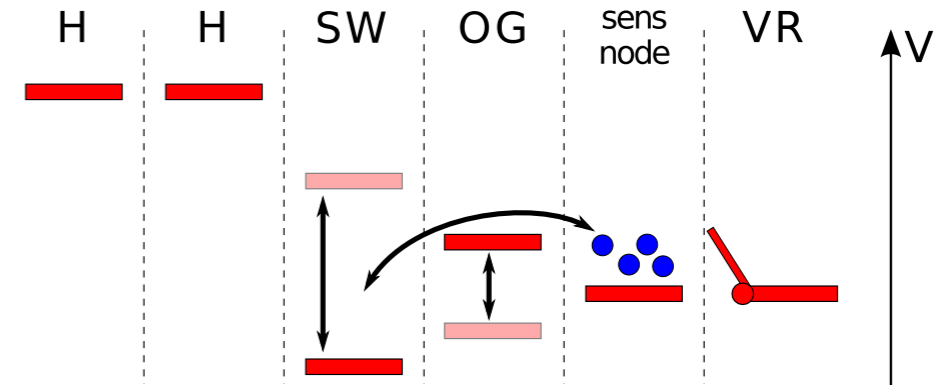
CCD: readout



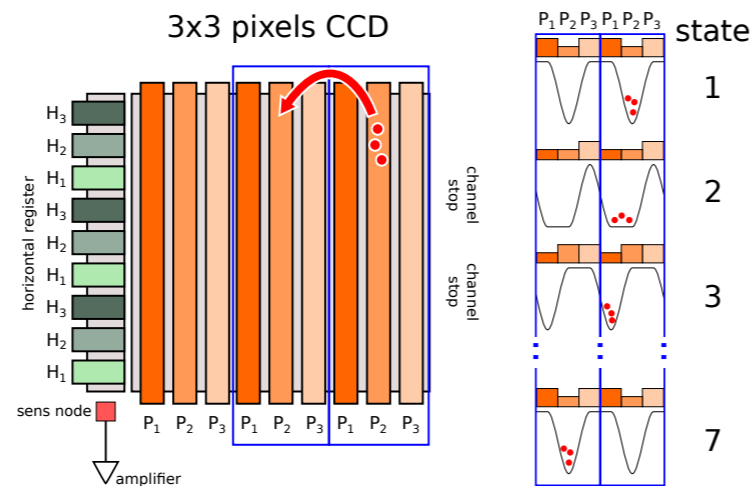
Lowering the noise: Skipper CCD

- **Main difference:** the Skipper CCD allows multiple sampling of the same pixel without corrupting the charge packet.
- The final pixel value is the average of the samples

$$\text{Pixel value} = \frac{1}{N} \sum_i^N (\text{pixel sample})_i$$



CCD: readout

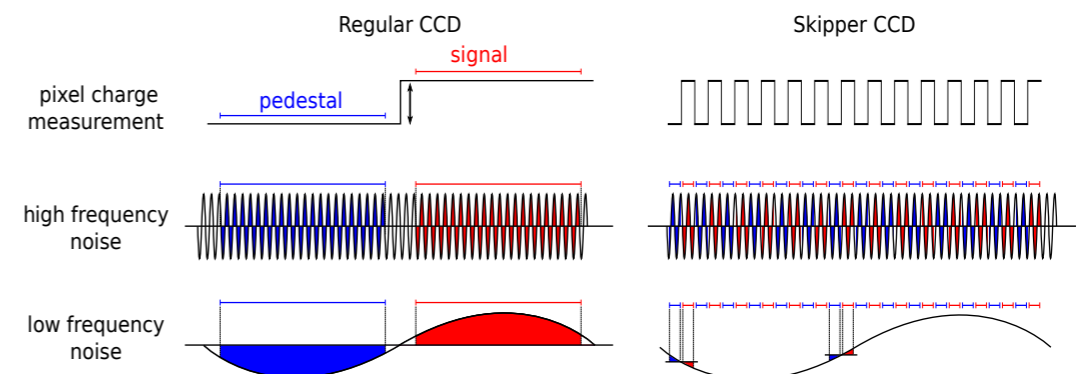


capacitance of the system is set by the SN: $C=0.05\text{pF} \rightarrow 3\mu\text{V}/e$

Lowering the noise: Skipper CCD

- **Main difference:** the Skipper CCD allows multiple sampling of the same pixel without corrupting the charge packet.
- The final pixel value is the average of the samples

$$\text{Pixel value} = \frac{1}{N} \sum_i^N (\text{pixel sample})_i$$

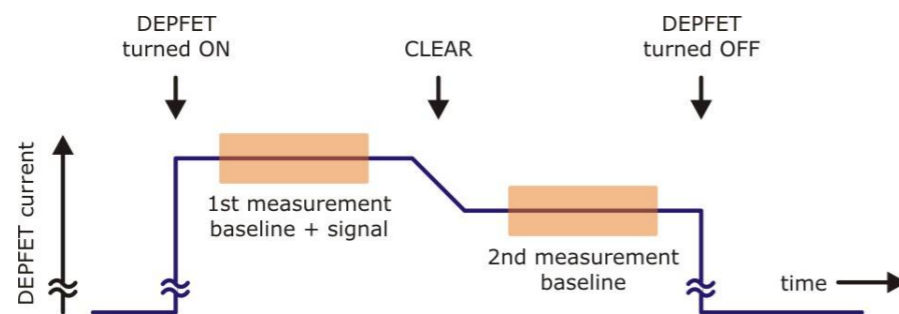


DEPFET CDS circle



Detector Structures – Matrix Devices

readout sequence



Correlated double sampling:

1st measurement: signal + baseline

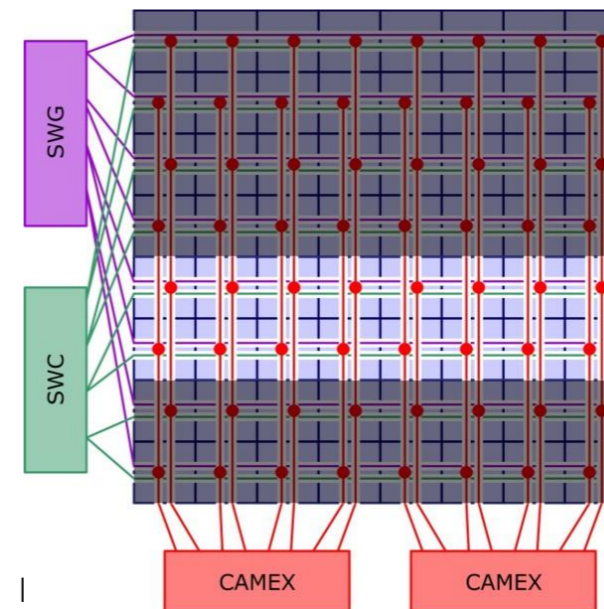
clear: removal of signal charges

2nd measurement: baseline

difference = signal

complete clear is mandatory!

matrix operation



vertical signal lines

1 active row, other pixels integrating

option to speed up (1)

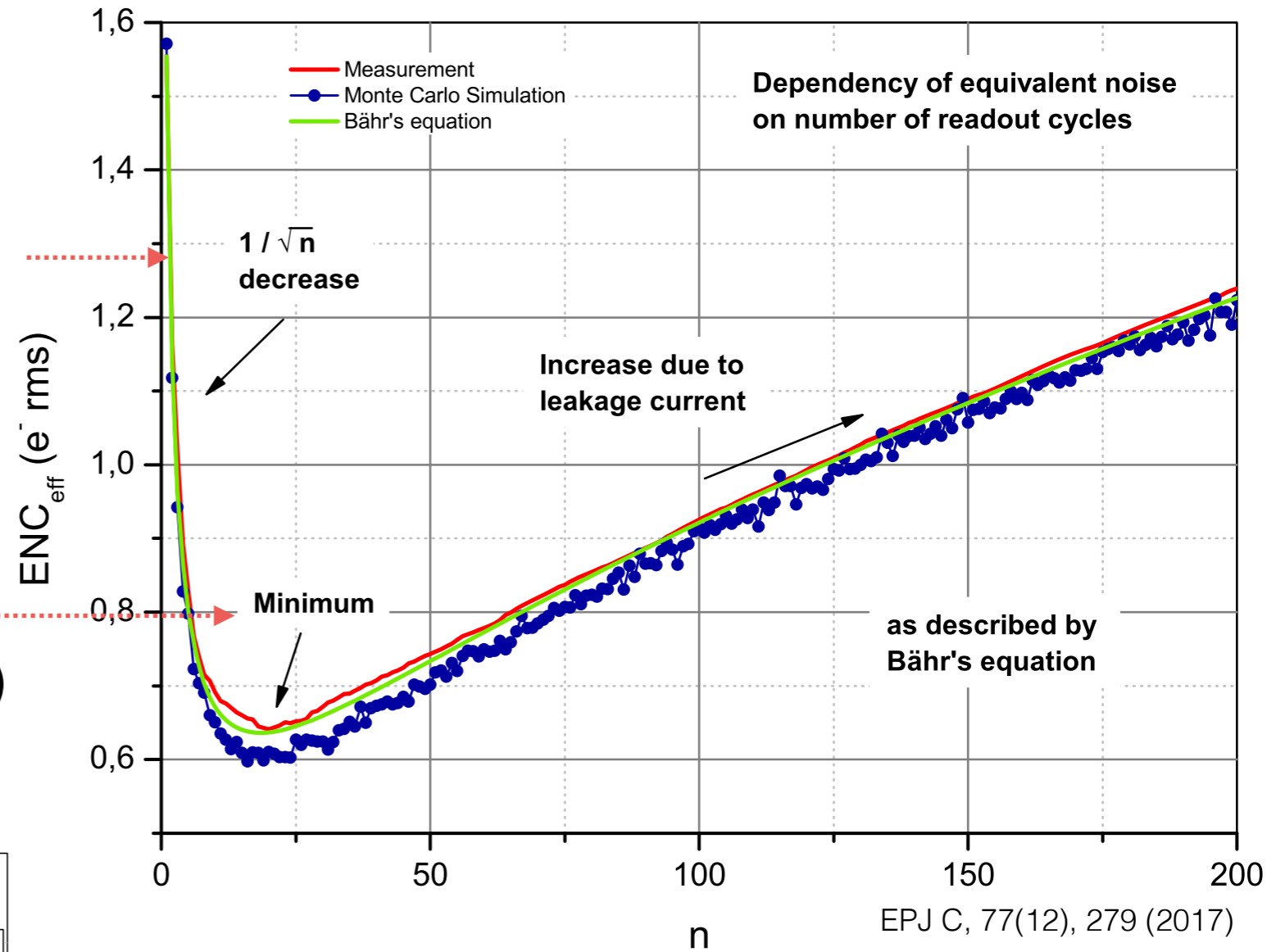
readout parallelisation

2 x readout channels, 2 active rows

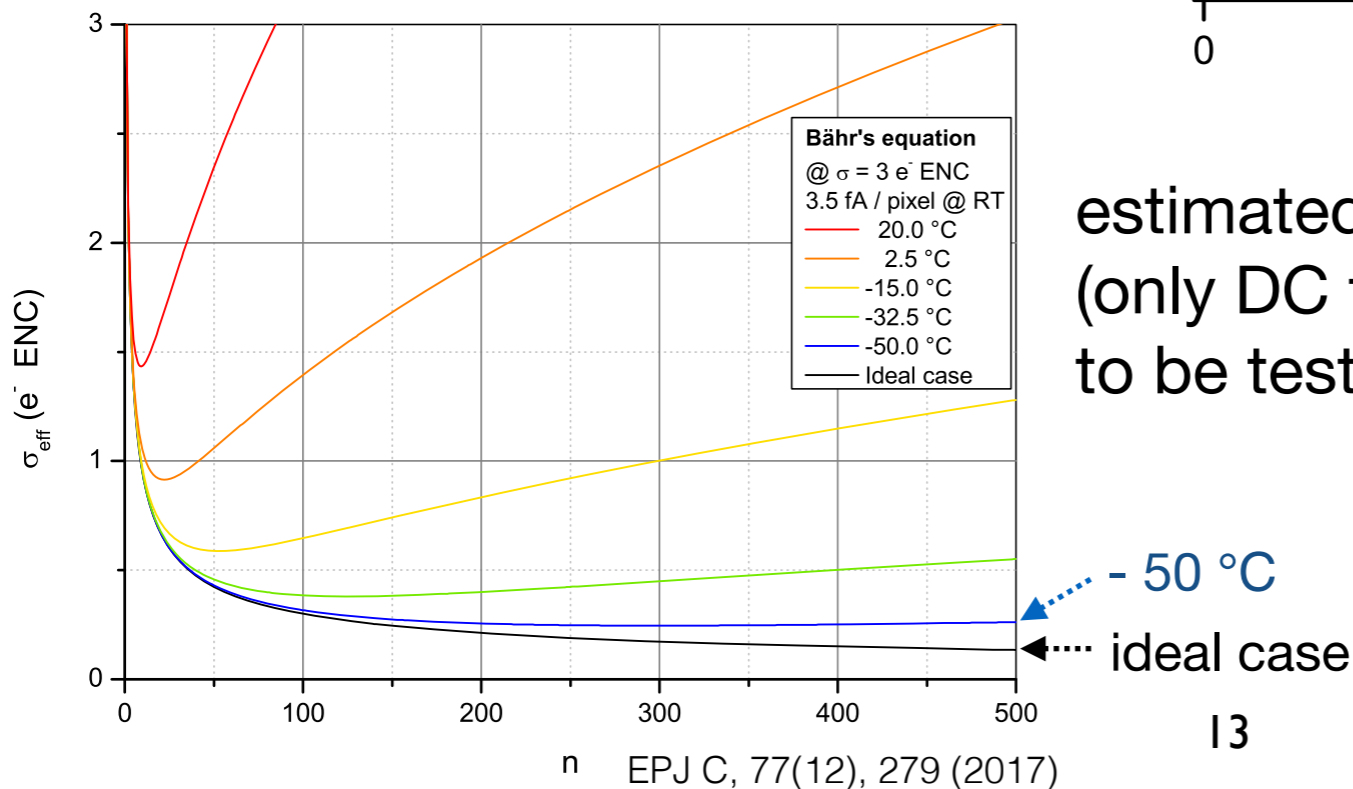
DEPFET RNDR single pixel performance

confirmed the $1/\sqrt{N}$ decrease of σ_{eff}

minimal noise level limited by leakage current at 230 K (-40 °C)



estimated temperature dependence (only DC from thermal excitation) to be testified in measurement



new architecture with “blind-gate” possibility of reducing leakage current during readout